

Product Description

Qorvo's QPA1011 is a X-band high power MMIC amplifier fabricated on Qorvo's production 0.15um GaN on SiC process (QGaN15). The QPA1011 operates from 7.9 – 11 GHz and typically provides 25 W saturated output power with power-added efficiency of 37.5% and large-signal gain of 19.5 dB. This combination of wideband performance provides the flexibility designers are looking for to improve system performance while reducing size and cost.

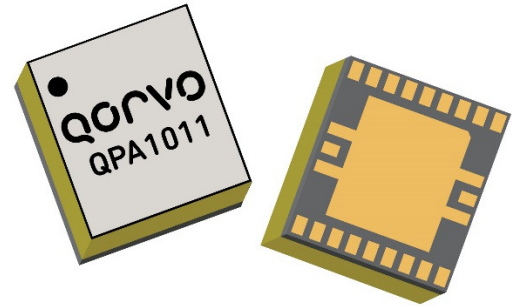
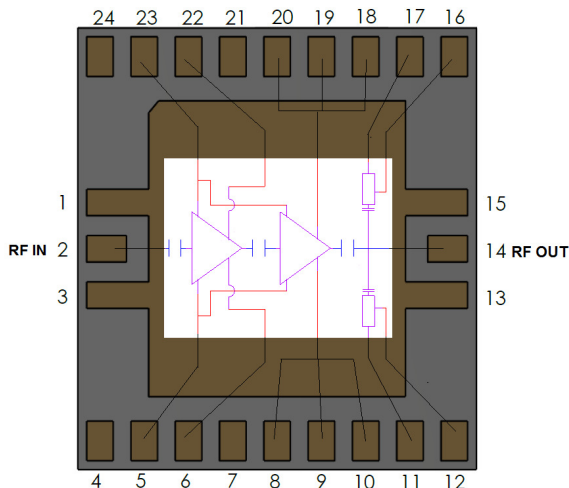
QPA1011 can also support a variety of operating conditions to best support system requirements. With good thermal properties, it can support a range of bias voltages and will perform well under both CW and pulse operations.

The QPA1011 is matched to 50Ω with integrated DC blocking capacitors on both RF I/O ports simplifying system integration. The wideband performance and operational flexibility allows it support satellite communication and data links, as well as, military and commercial radar systems.

Lead-free and RoHS compliant.

Evaluation boards are available upon request.

Functional Block Diagram



Product Features

- Frequency Range: 7.9–11 GHz
- P_{OUT} : 44.5 dBm at $P_{IN} = 25$ dBm
- PAE: 37.5 % at $P_{IN} = 25$ dBm
- Large Signal Gain: 19.5 dB at $P_{IN} = 25$ dBm
- Small Signal Gain: 26 dB
- Integrated Power Detector
- Bias: $V_D = 24$ V, $I_{DQ} = 1200$ mA, $V_G = -1.9$ V Typical
- Pulsed V_D : PW = 100 μ S, DC = 10%
- Package Dimensions: 4.5 x 5.0 x 1.72 mm

Performance is typical across frequency. Please reference electrical specification table and data plots for more details.

Applications

- Satellite Communications
- Data Links
- Military and Commercial Radar

Ordering Information

| Part No. | ECCN | Description |
|----------|---------------|---------------------------------------|
| QPA1011 | 3A001.b.2.b.2 | 7.9 – 11 GHz 25 W GaN Power Amplifier |

Absolute Maximum Ratings

| Parameter | Value / Range |
|--|-------------------|
| Drain Voltage (V_D) | 29.5 V |
| Gate Voltage Range (V_G) | –8 to 0V |
| Drain Current (I_{D1}/I_{D2}) | 672 mA / 2880 mA |
| Gate Current (I_G) | See chart, pg. 21 |
| Power Dissipation (P_{DISS}), 85 °C, CW | 70 W |
| Input Power (P_{IN}), CW, 50Ω, $V_D=28$ V, $I_{DQ}=1200$ mA, 85 °C | 30 dBm |
| Input Power (P_{IN}), CW, VSWR 3:1, $V_D=28$ V, $I_{DQ}=1200$ mA 85 °C | 30 dBm |
| Channel Temperature (T_{CH}) | 275 °C |
| Mounting Temperature (30 seconds) | 260 °C |
| Storage Temperature | –55 to 150 °C |

Operation of this device outside the parameter ranges given above may cause permanent damage. These are stress ratings only, and functional operation of the device at these conditions is not implied.

Electrical Specifications

| Parameter | | Min | Typ | Max | Units |
|--|---------------------------------|-----|-------------------------|-----|-------------------|
| Operational Frequency Range | | 7.9 | | 11 | GHz |
| Output Power ($P_{IN} = 25$ dBm) | 7.9 GHz 9.0 GHz 11.0 GHz | | 44.2 45.0 44.8 | | dBm dBm dBm |
| Power Added Efficiency ($P_{IN} = 25$ dBm) | 7.9 GHz 9.0 GHz 11.0 GHz | | 35.6 38.7 39.4 | | % % % |
| 3 rd Order Intermodulation Level ($P_{OUT}/\text{Tone} = 38$ dBm) | 7.9 GHz 10.0 GHz 11.0 GHz | | –20.0 –21.2 –21.5 | | dBc dBc dBc |
| Small Signal Gain | 7.9 GHz 9.0 GHz 11.0 GHz | | 29.0 28.8 28.0 | | dB dB dB |
| Input Return Loss | 7.9 GHz 9.0 GHz 11.0 GHz | | 13.5 30.0 17.5 | | dB dB dB |
| Output Return Loss | 7.9 GHz 9.0 GHz 11.0 GHz | | 9.0 10.0 16.0 | | dB dB dB |
| Output Power Temperature Coefficient (25–85 °C) ($P_{IN} = 25$ dBm) | | | –0.006 | | dB/°C |
| Small Signal Gain Temperature Coefficient (25–85 °C) | | | –0.053 | | dB/°C |
| Recommended Voltage Operations | | | 24 | 28 | V |

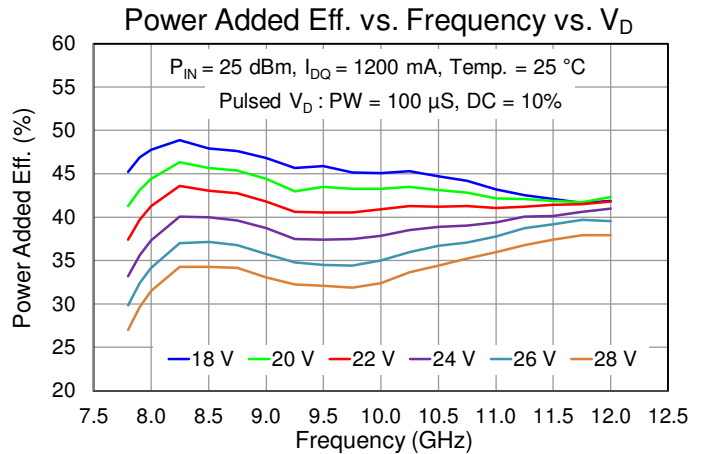
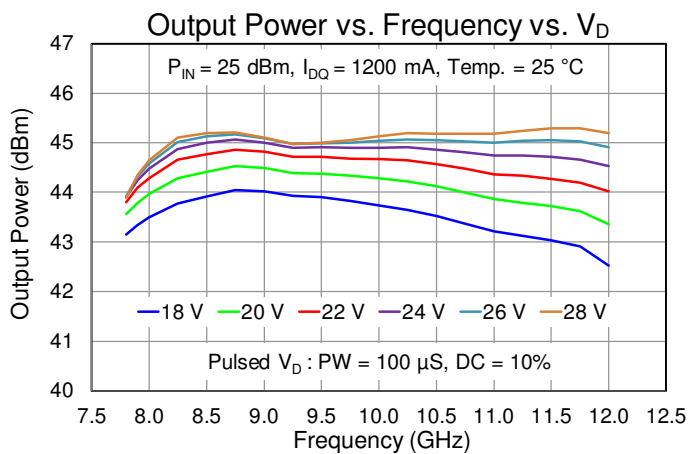
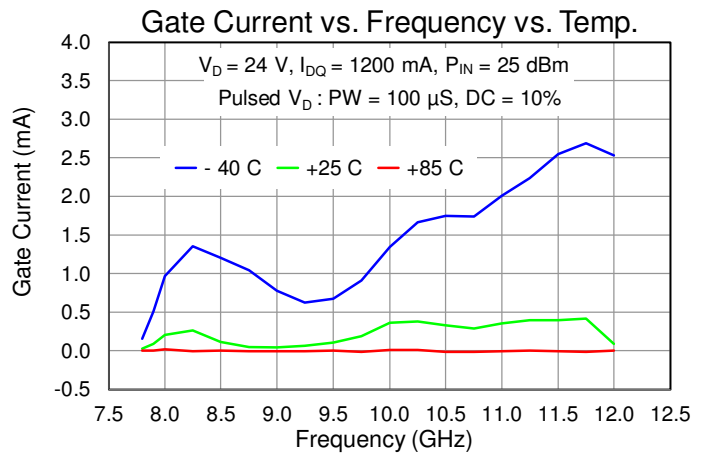
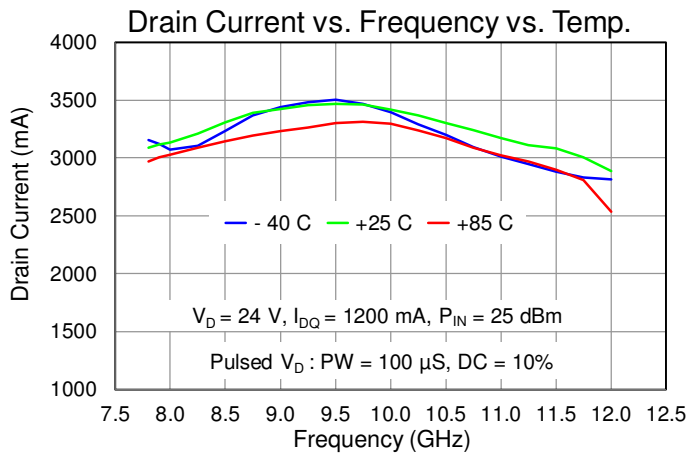
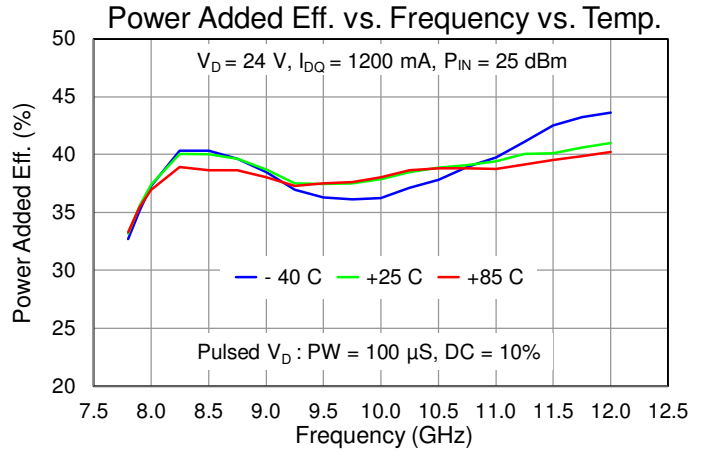
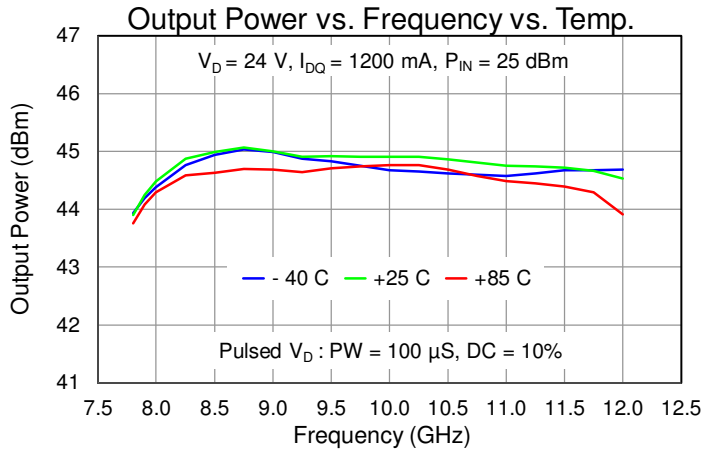
Test conditions, unless otherwise noted: 25 °C, Pulsed V_D : PW = 100 μS, DC = 10%, $V_D = 24$ V, $I_{DQ} = 1200$ mA, $V_G = -1.9$ V Typical

Recommended Operating Conditions

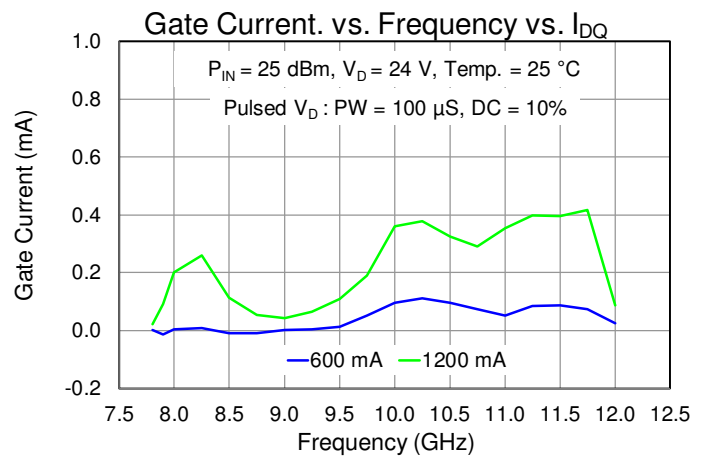
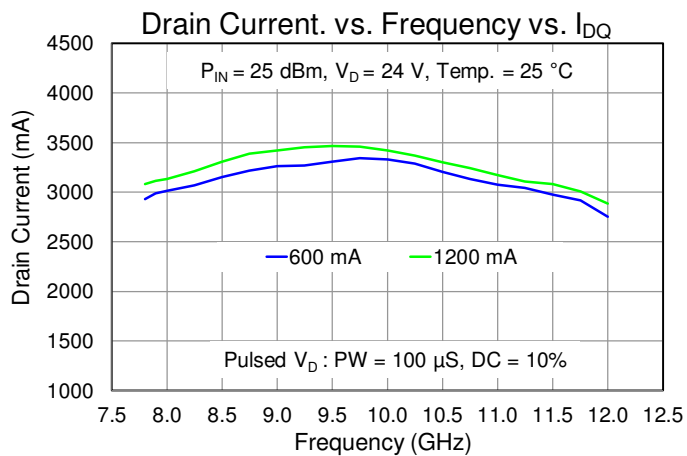
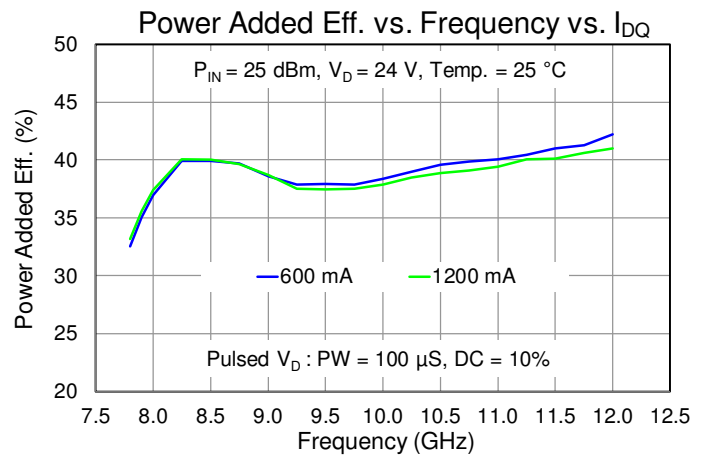
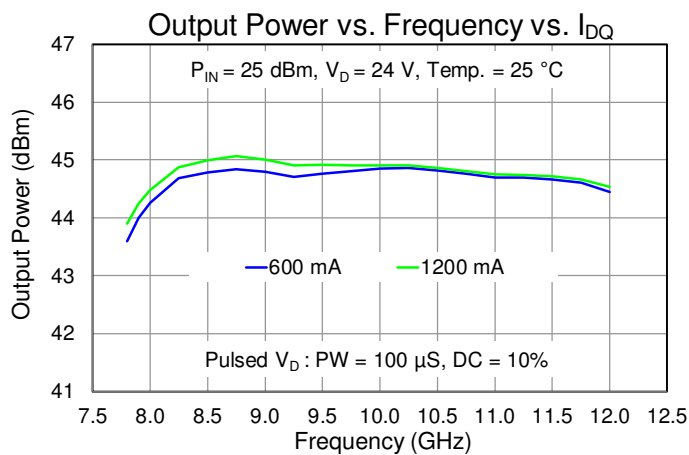
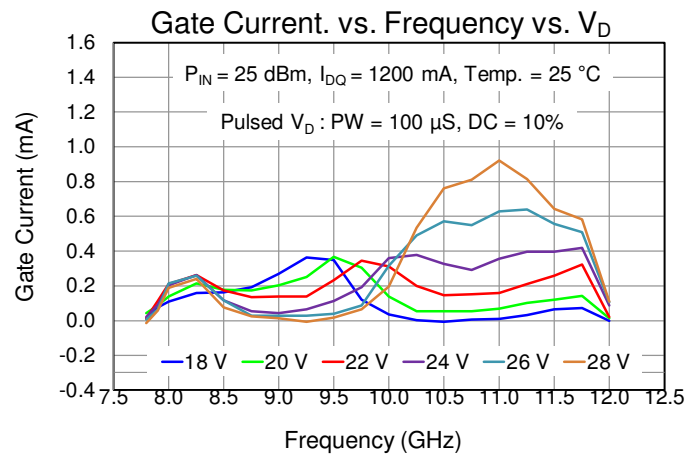
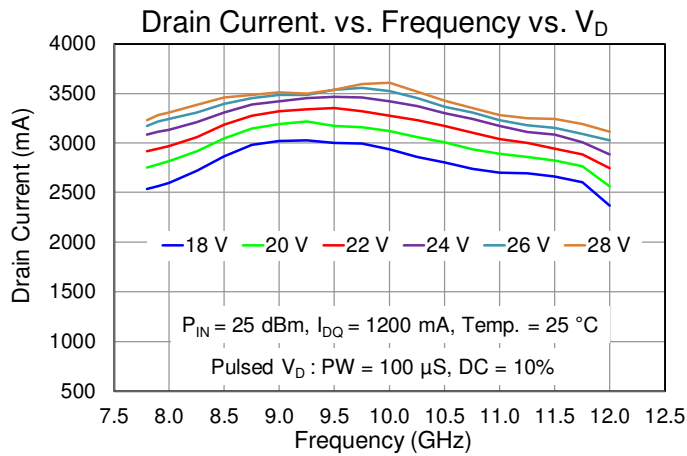
| Parameter | Value / Range |
|---------------------------------|---------------|
| Drain Voltage (V_D) | 24 V |
| Drain Current (I_{DQ}) | 1200 mA |
| Gate Voltage (V_G), Typical | –1.9 V |

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

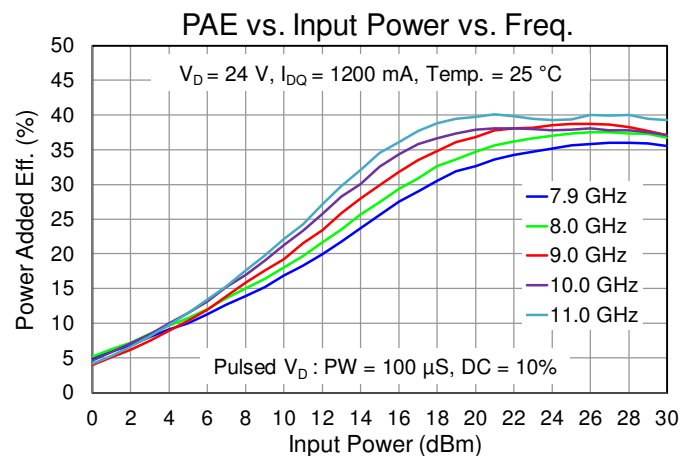
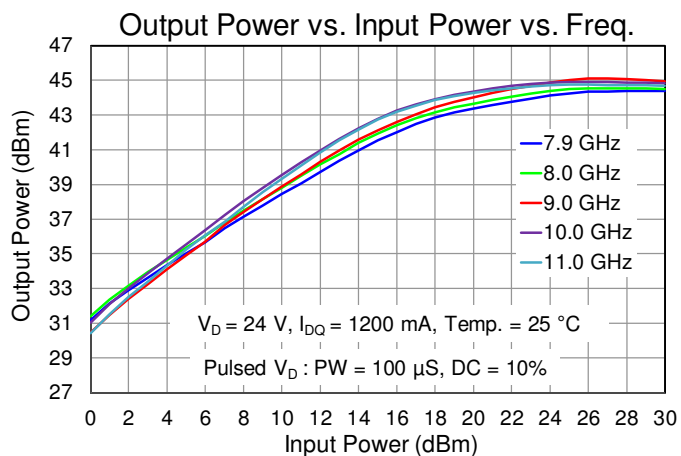
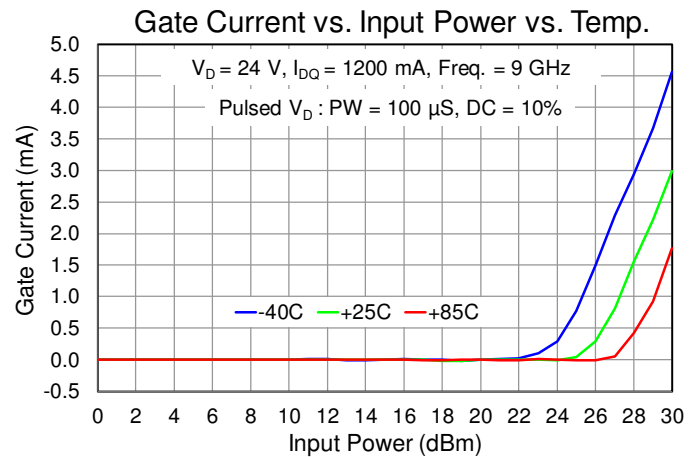
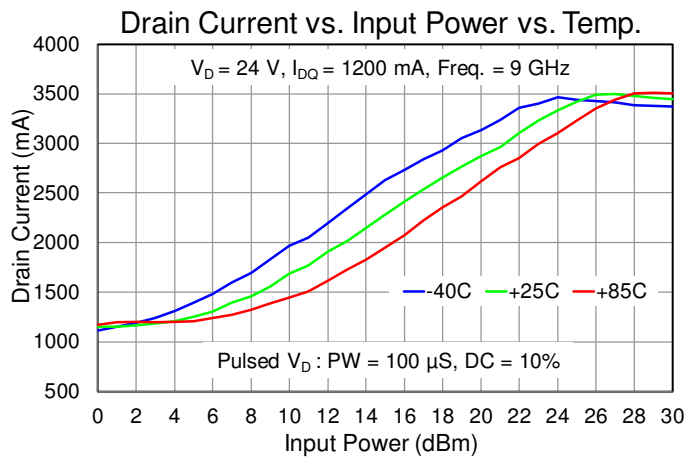
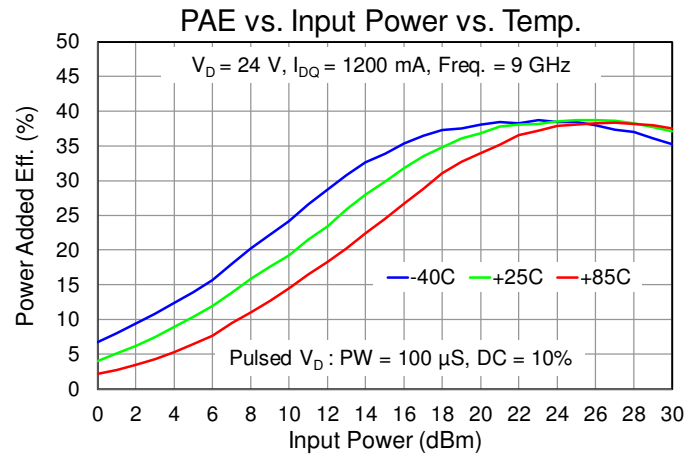
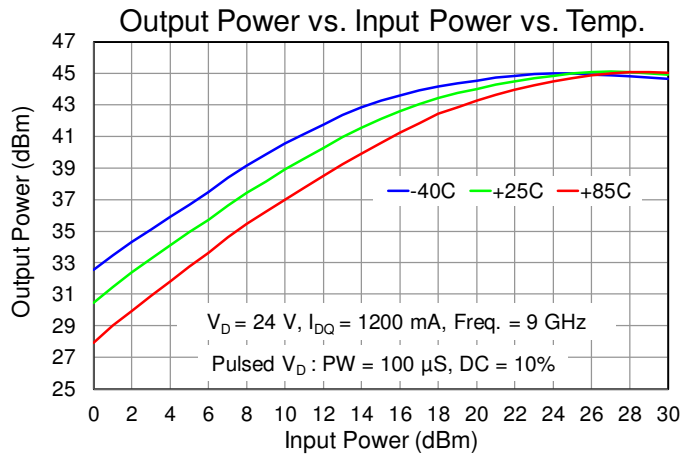
Performance Plots – Large Signal (Pulsed)



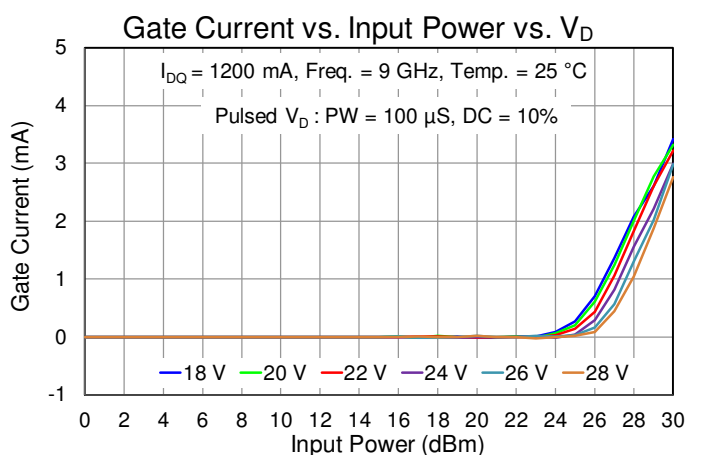
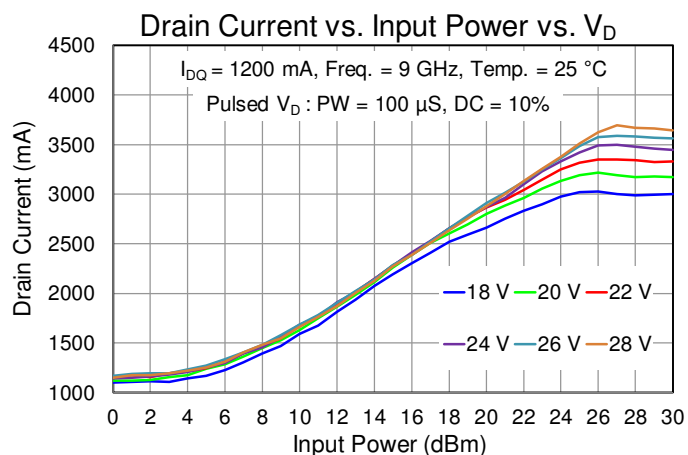
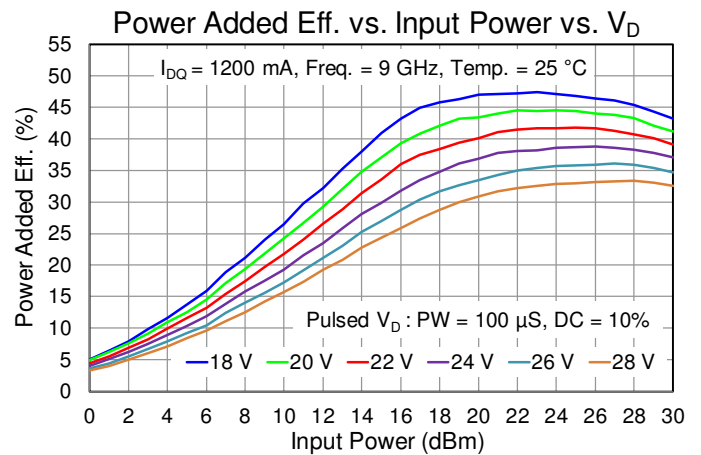
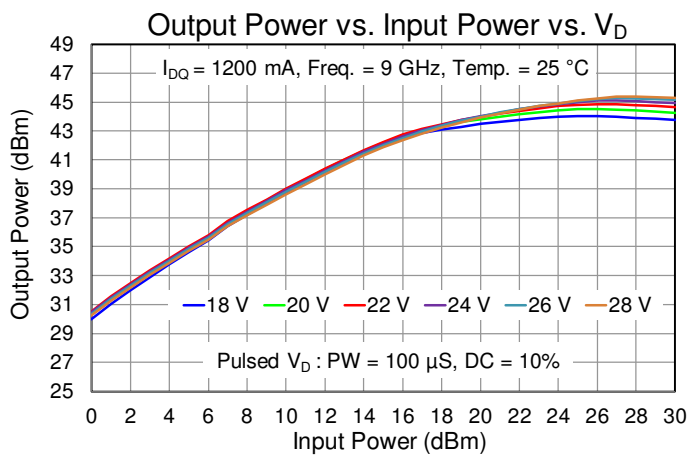
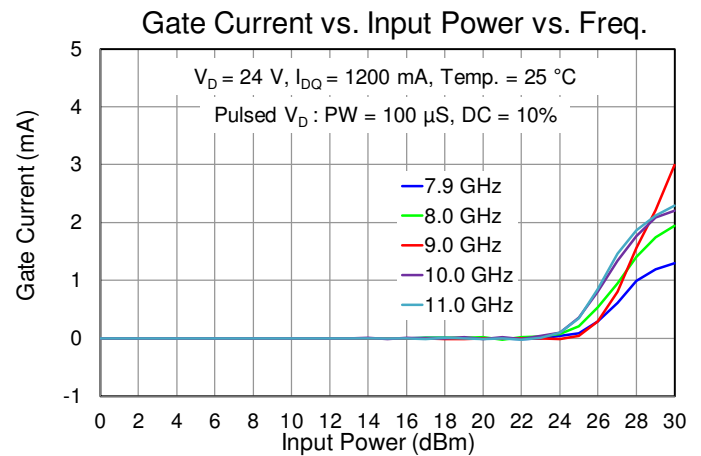
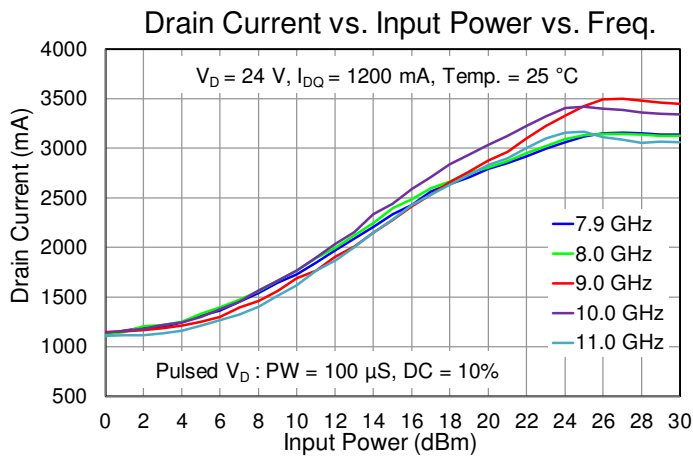
Performance Plots – Large Signal (Pulsed)



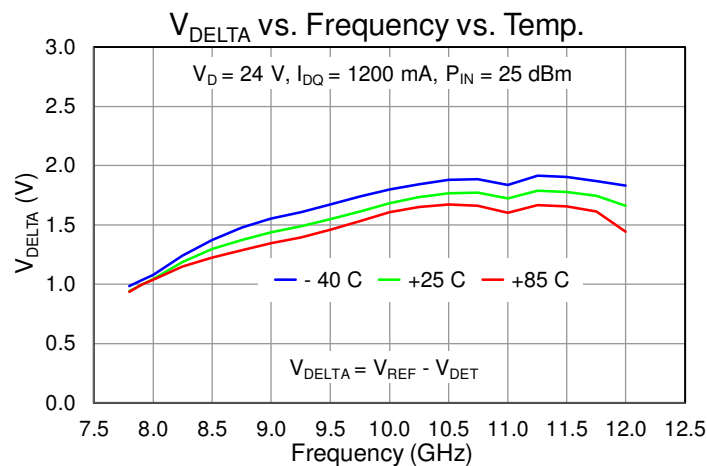
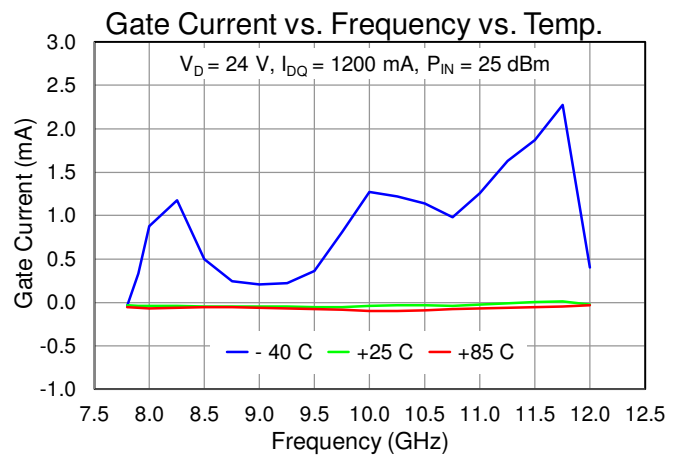
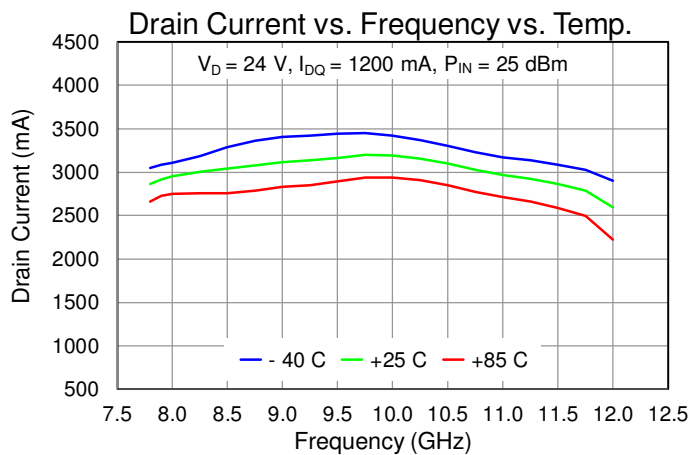
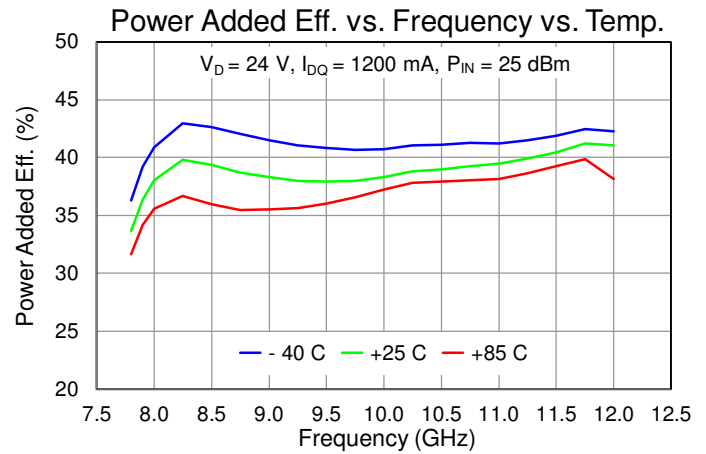
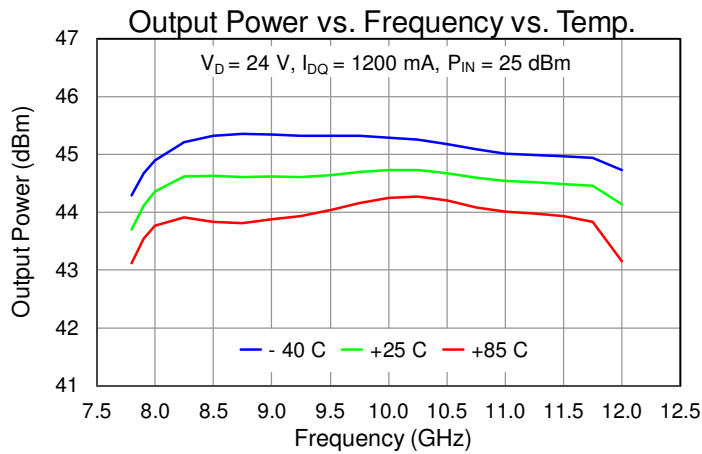
Performance Plots – Large Signal (Pulsed)



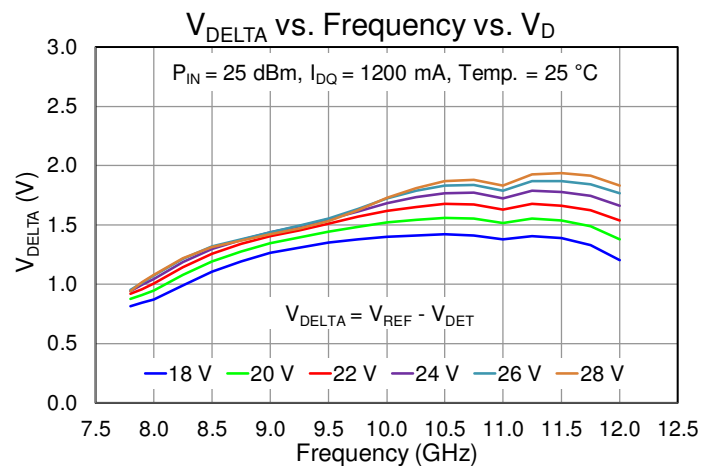
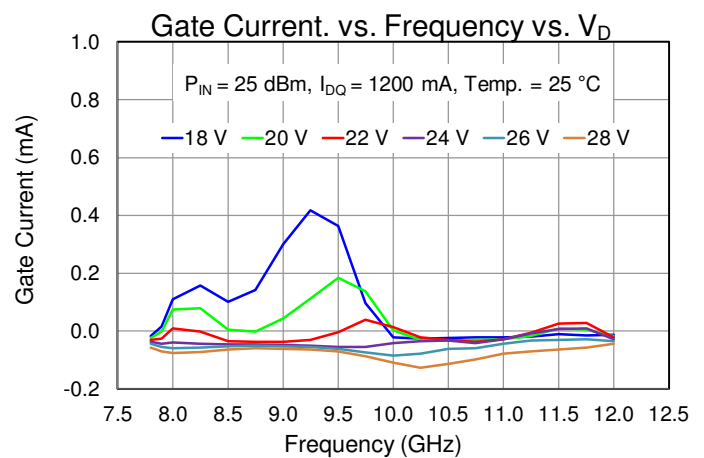
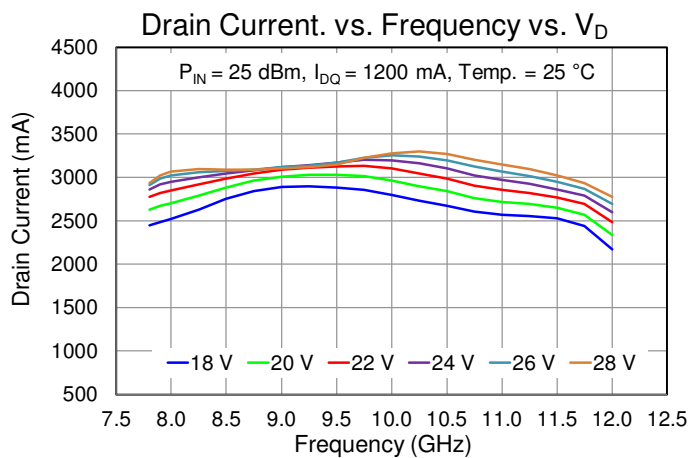
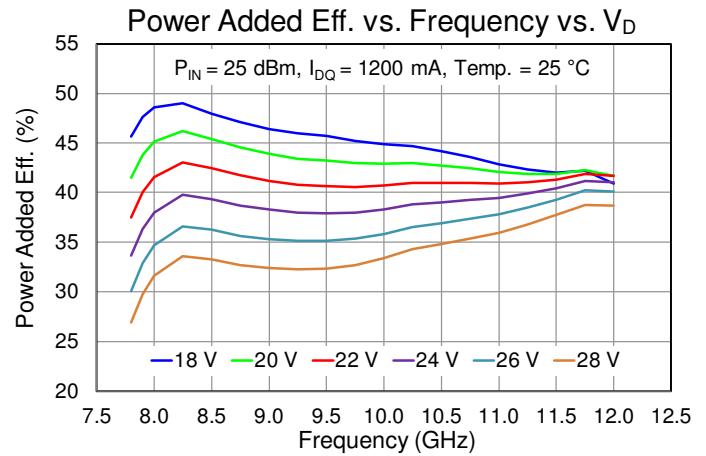
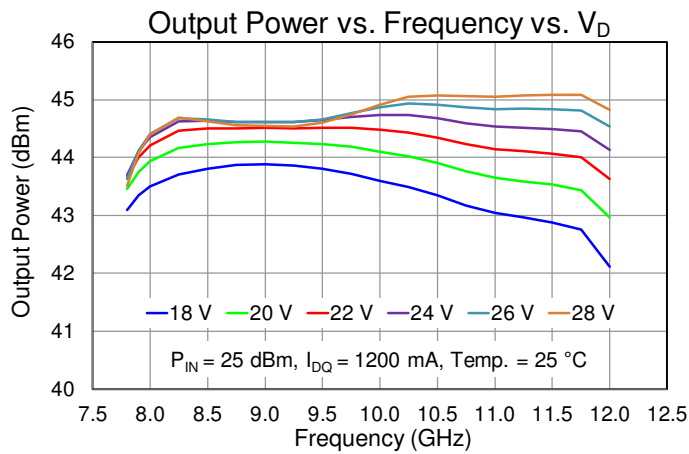
Performance Plots – Large Signal (Pulsed)



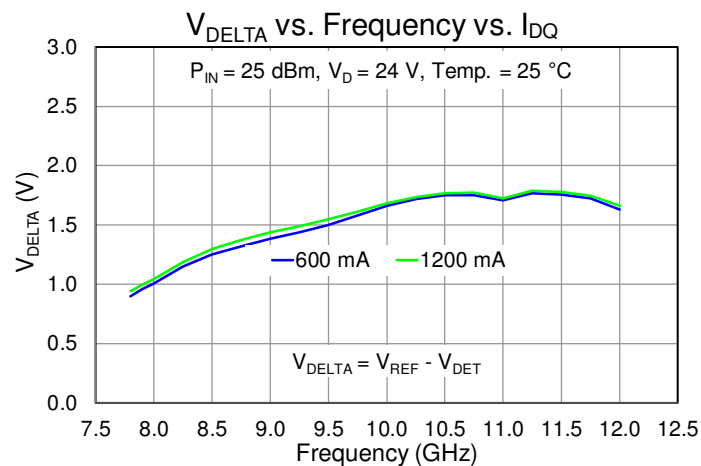
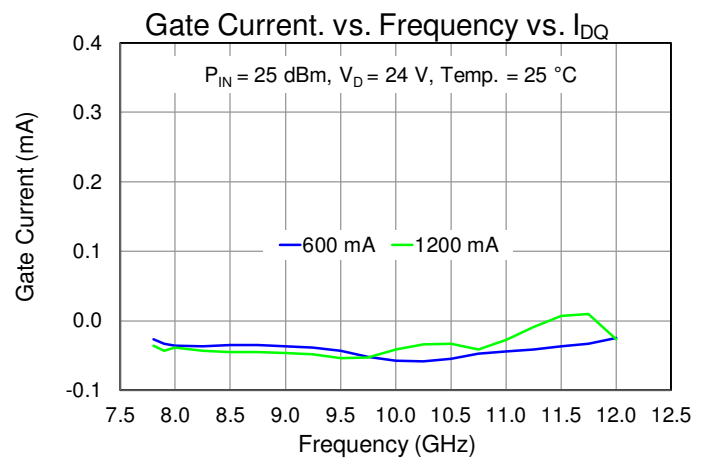
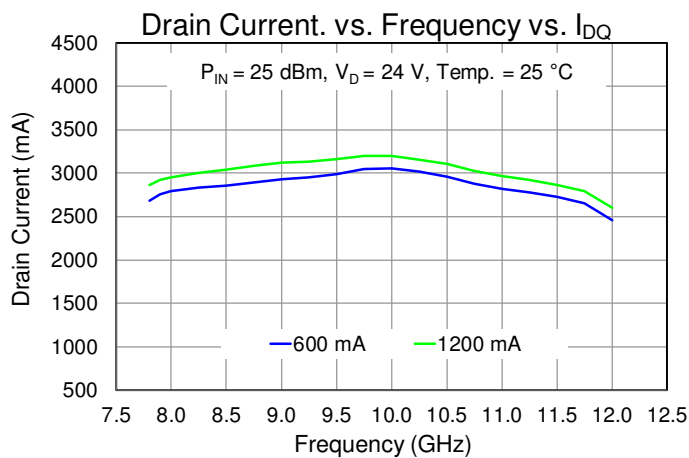
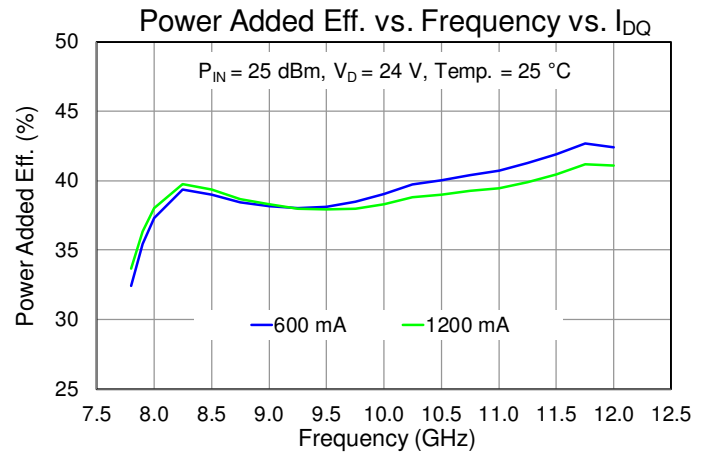
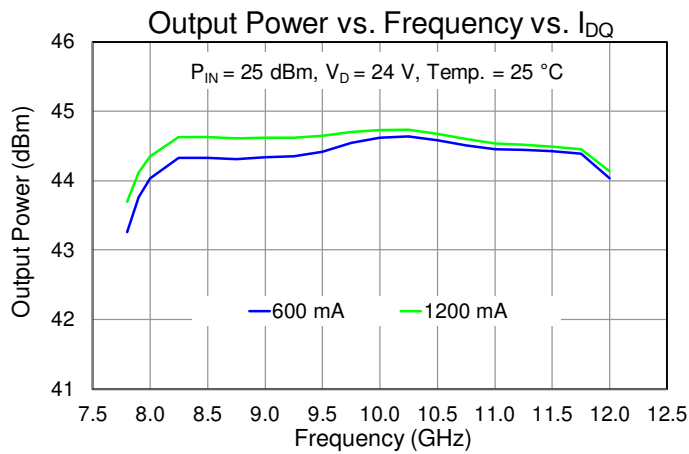
Performance Plots – Large Signal (CW)



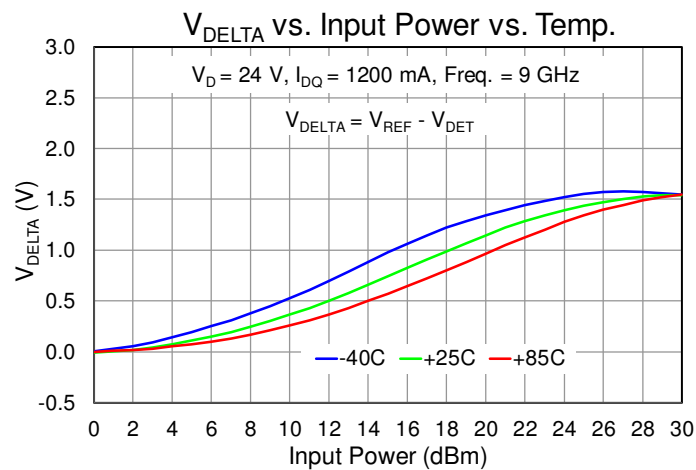
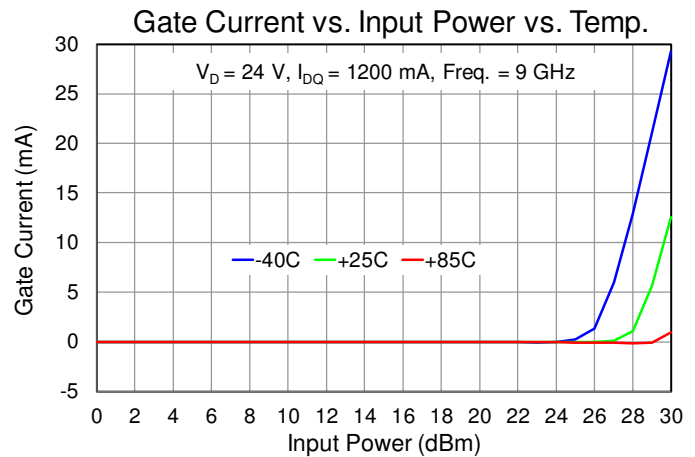
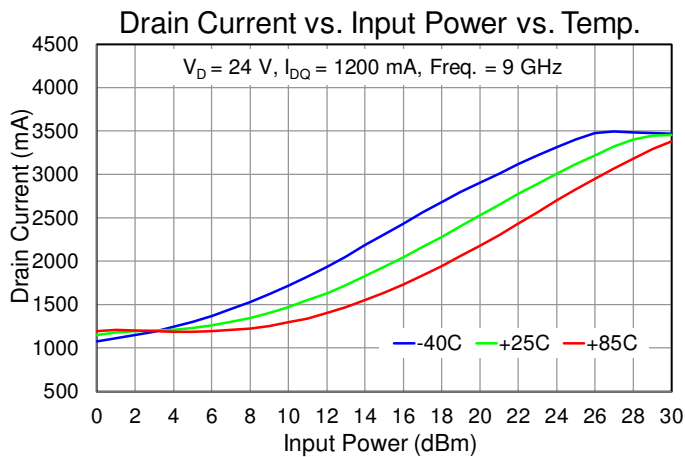
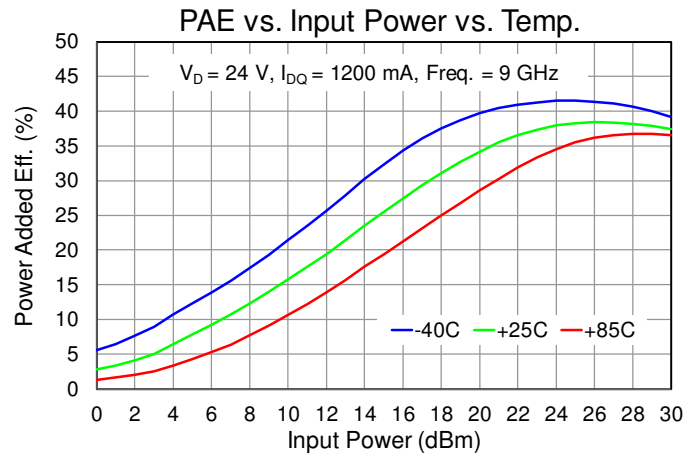
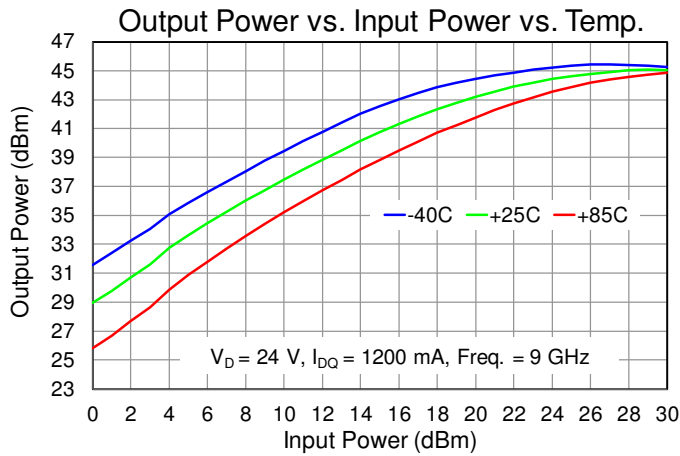
Performance Plots – Large Signal (CW)



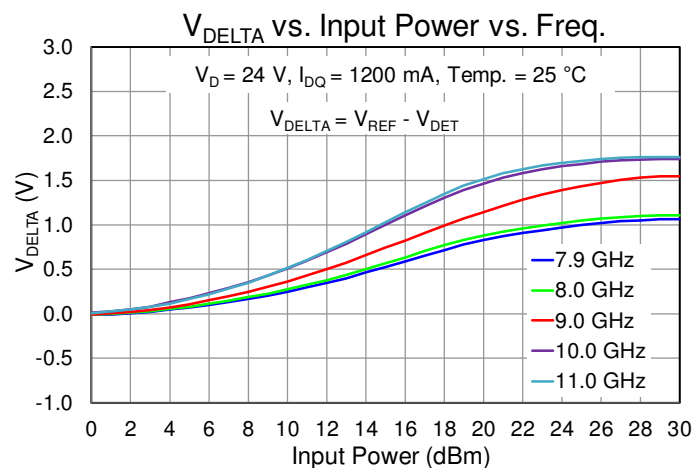
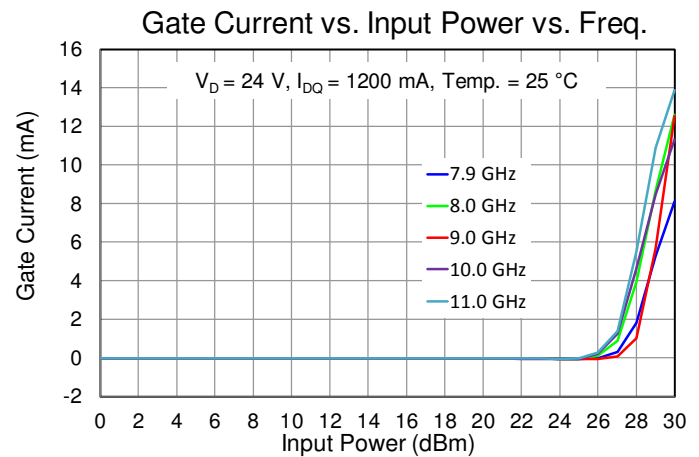
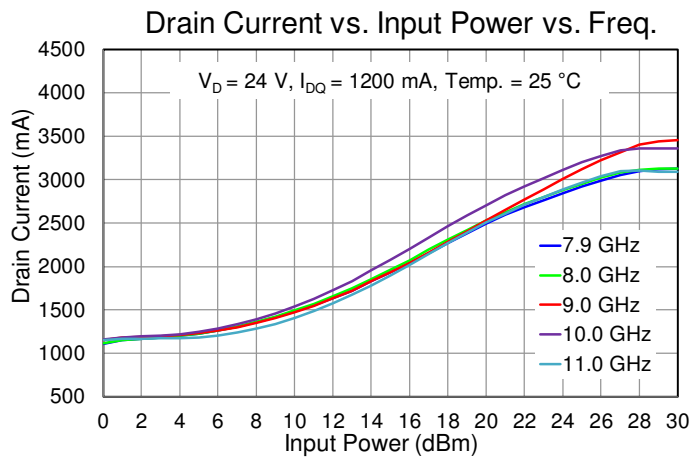
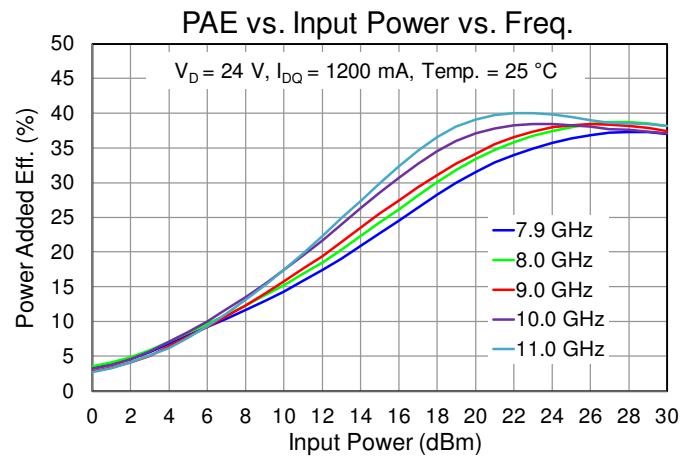
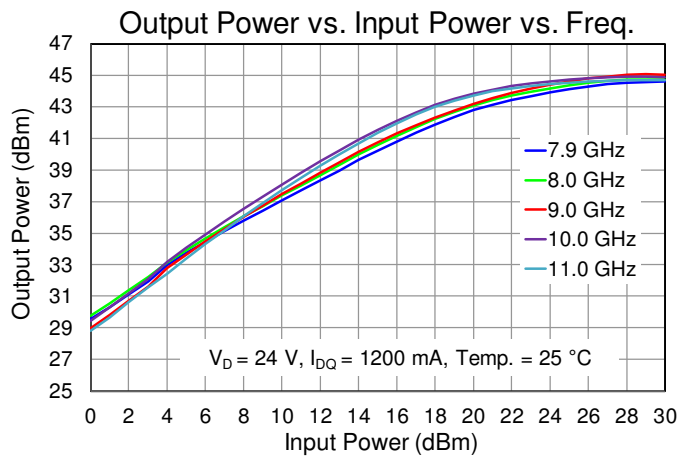
Performance Plots – Large Signal (CW)



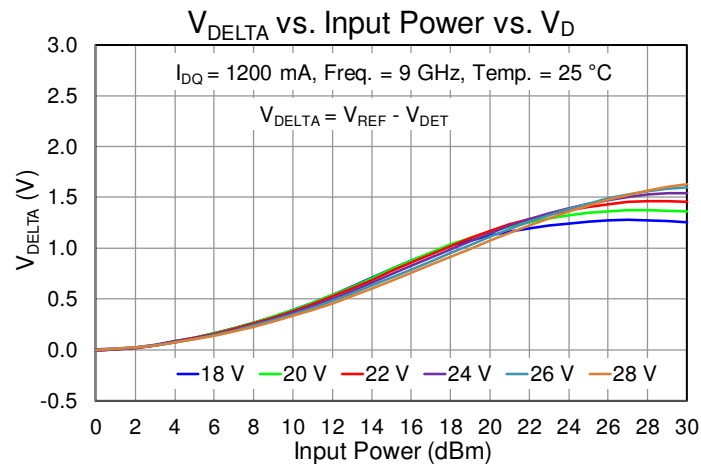
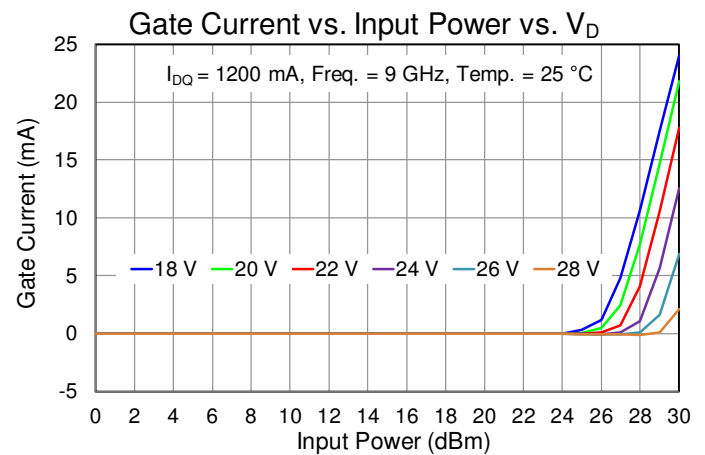
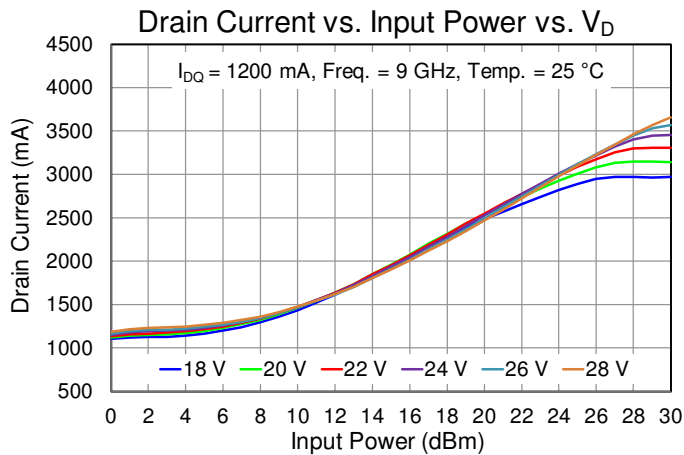
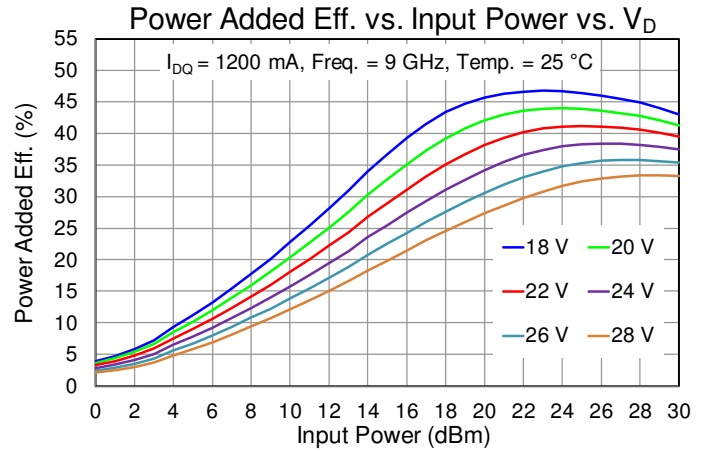
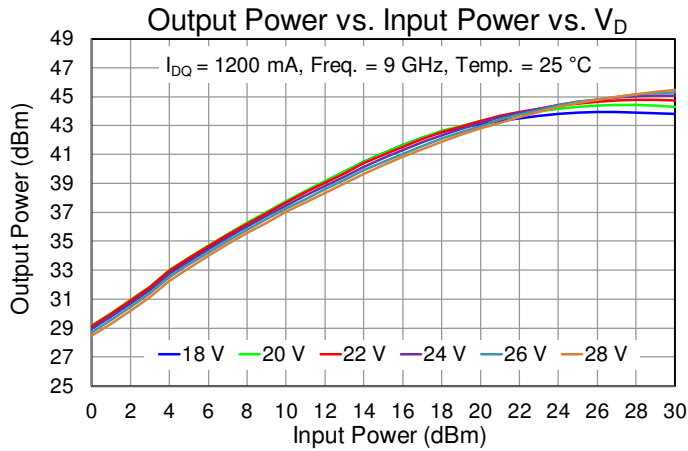
Performance Plots – Large Signal (CW)



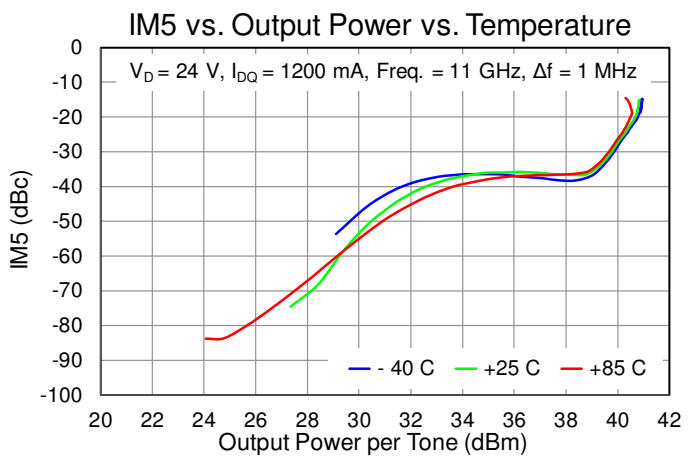
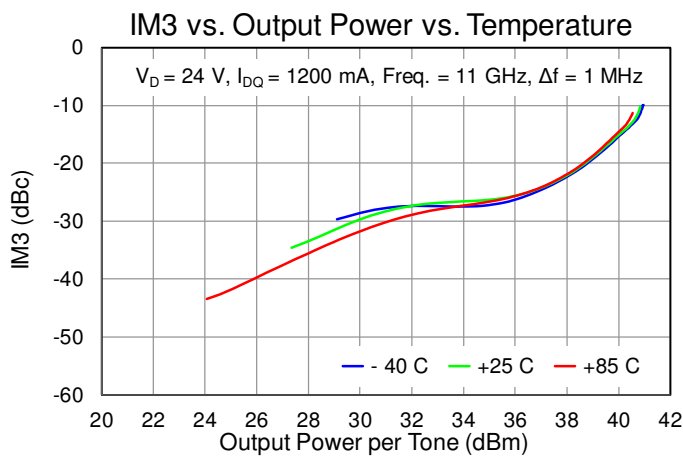
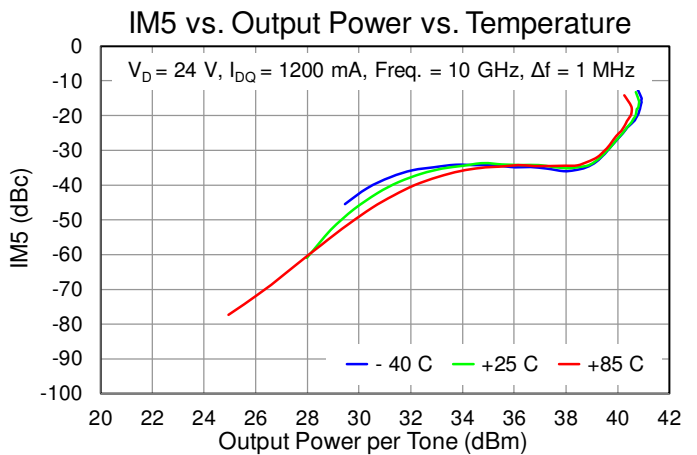
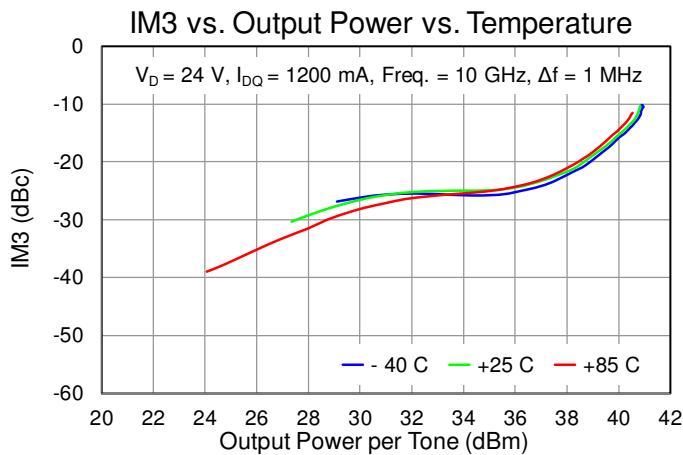
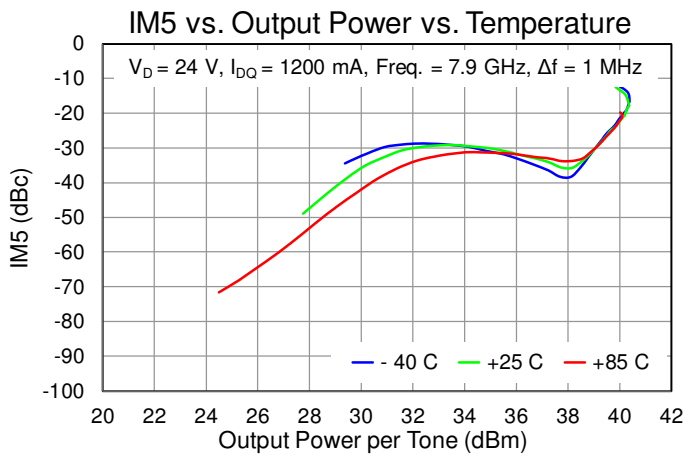
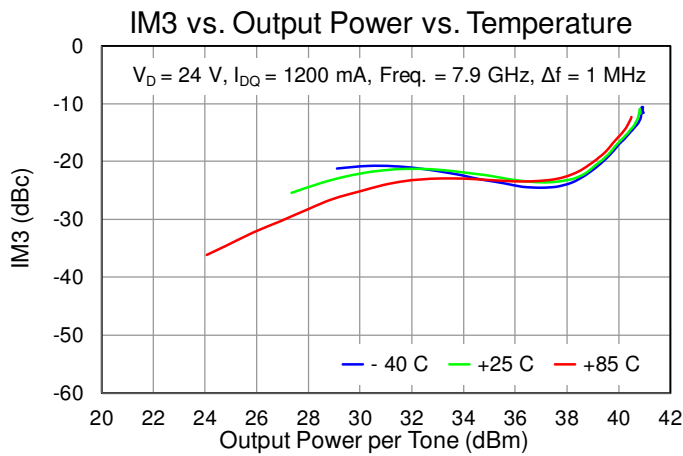
Performance Plots – Large Signal (CW)



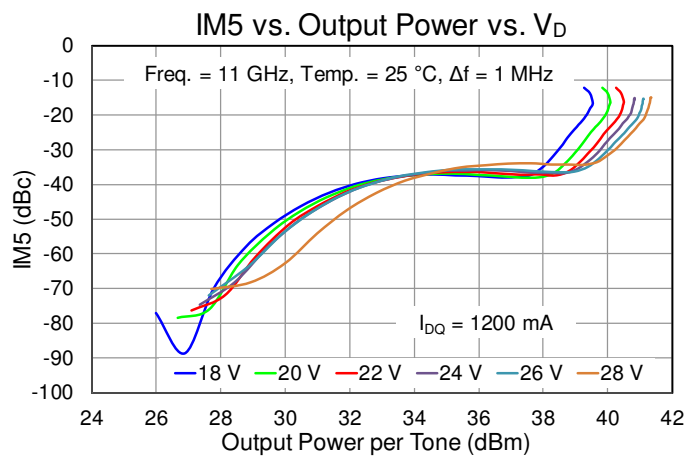
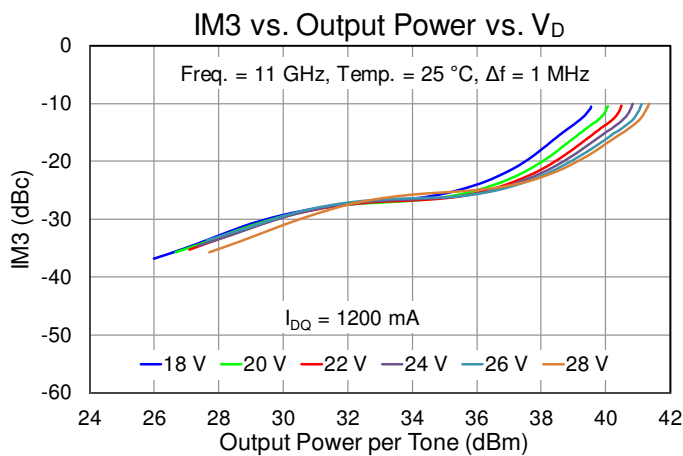
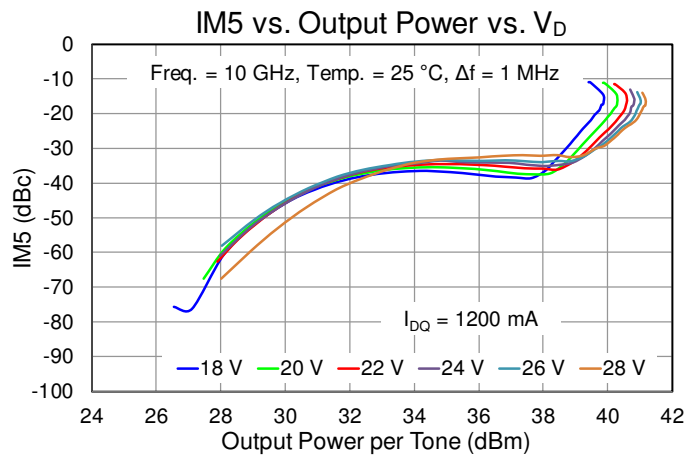
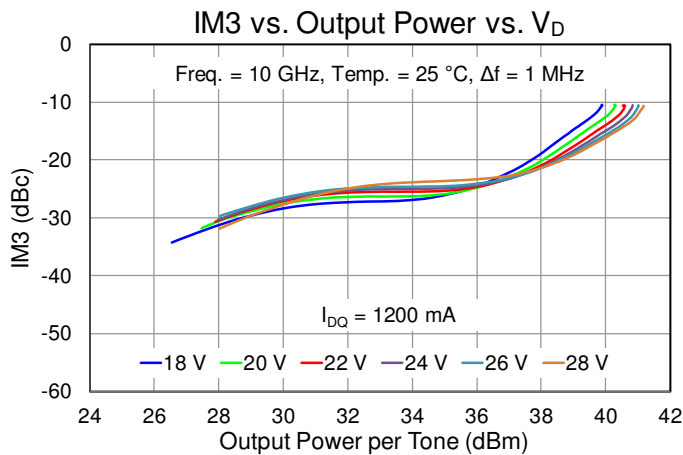
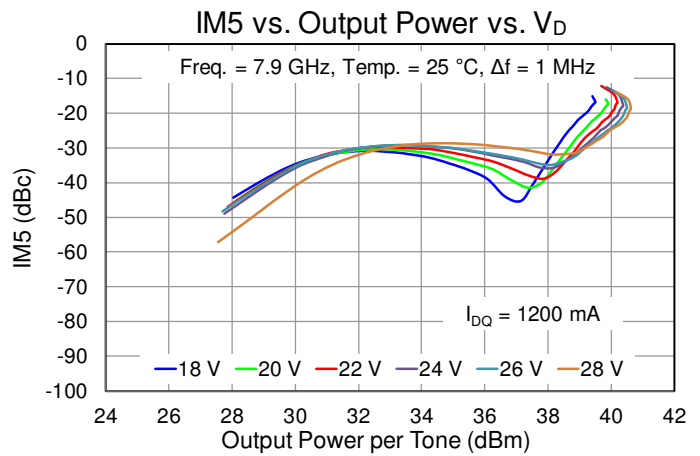
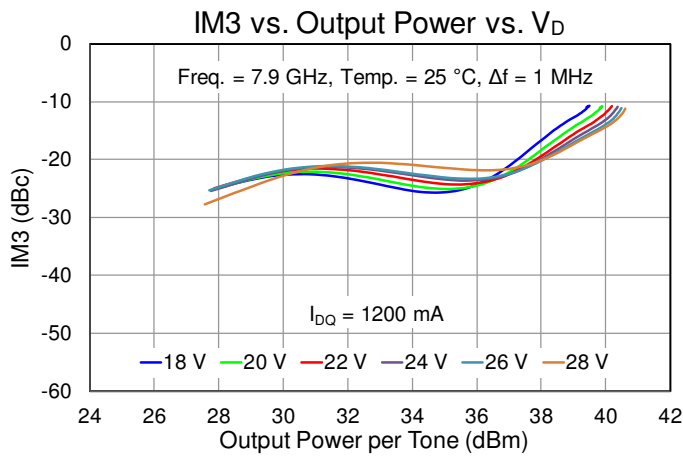
Performance Plots – Large Signal (CW)



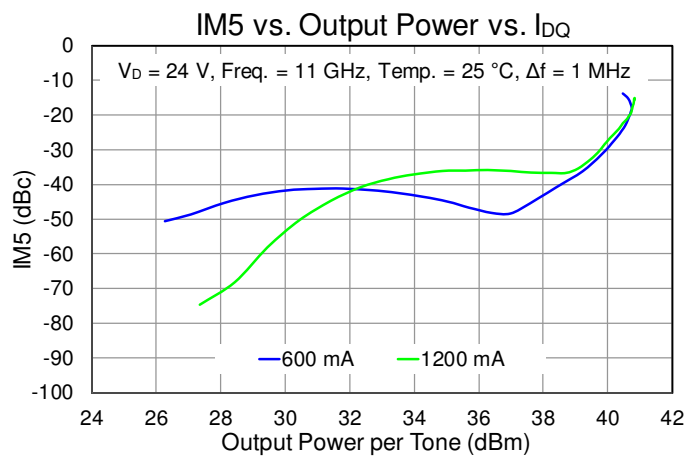
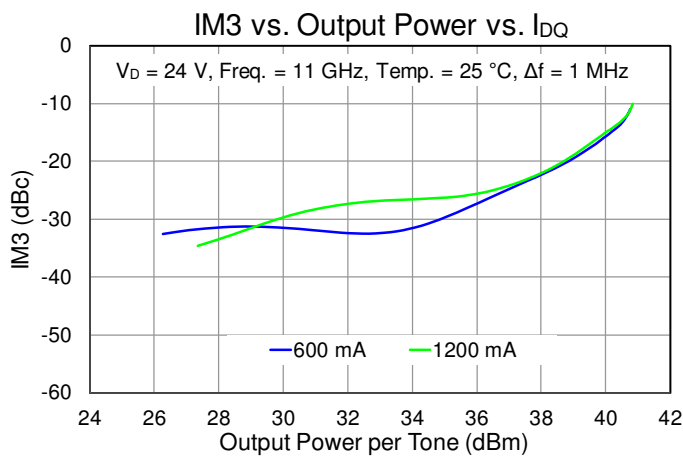
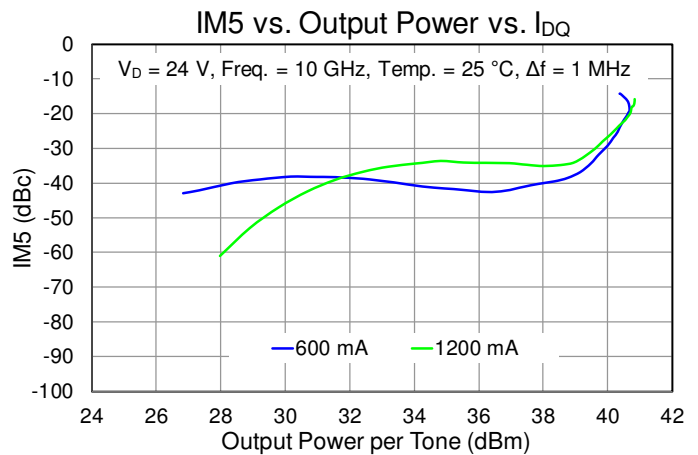
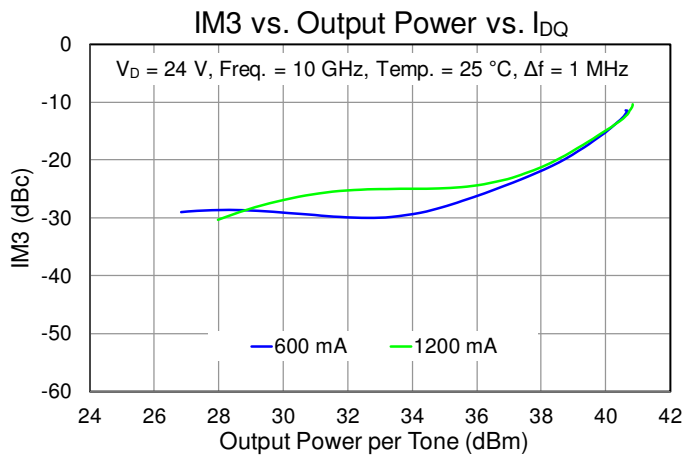
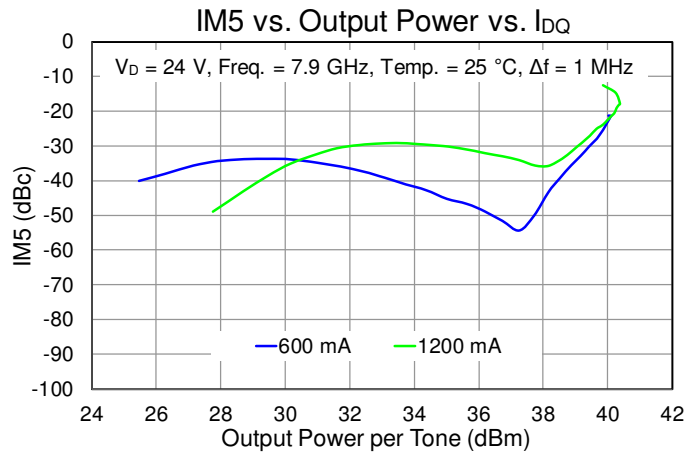
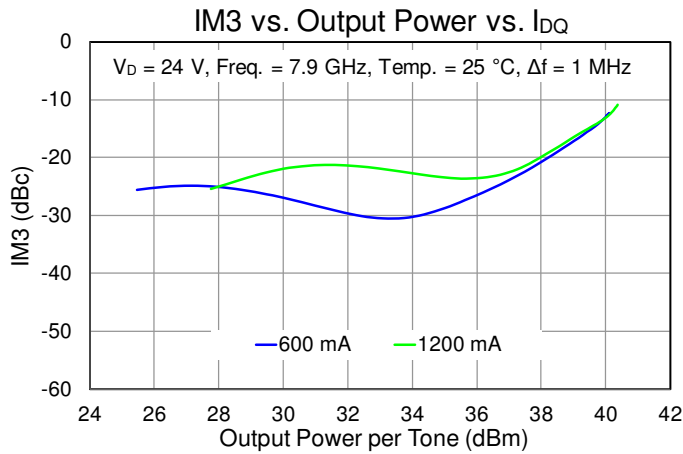
Performance Plots – Linearity



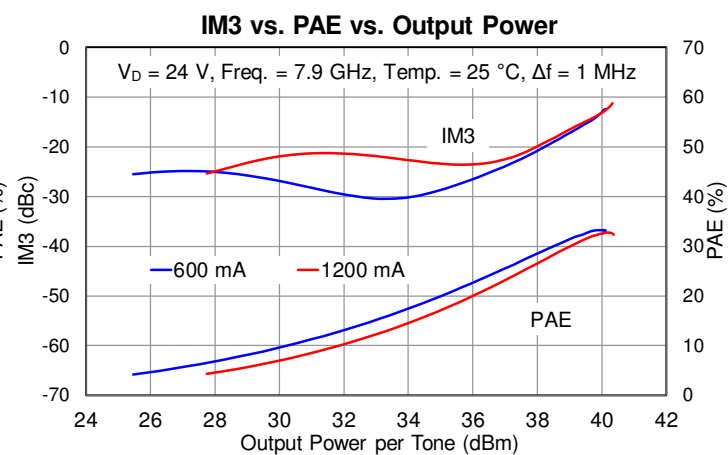
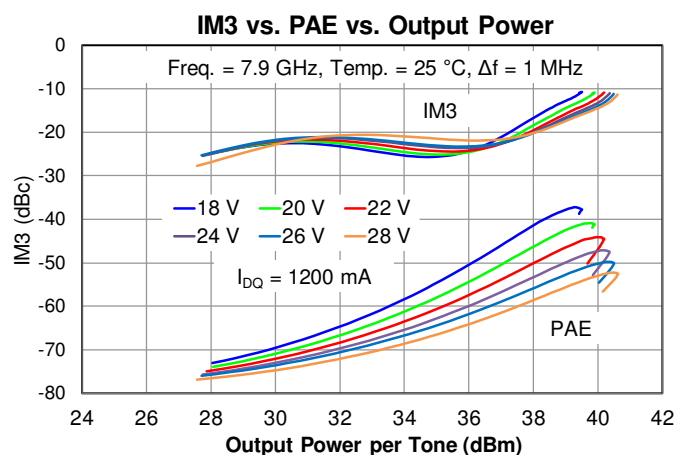
Performance Plots – Linearity



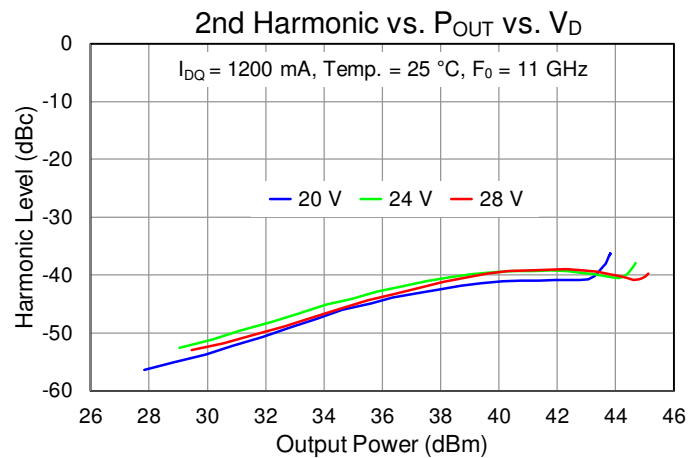
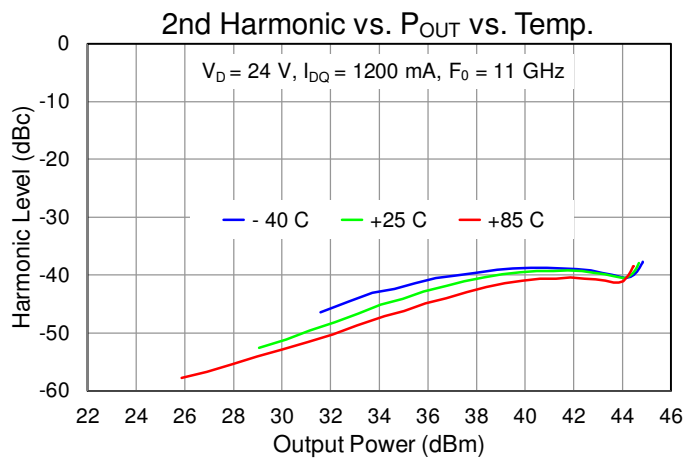
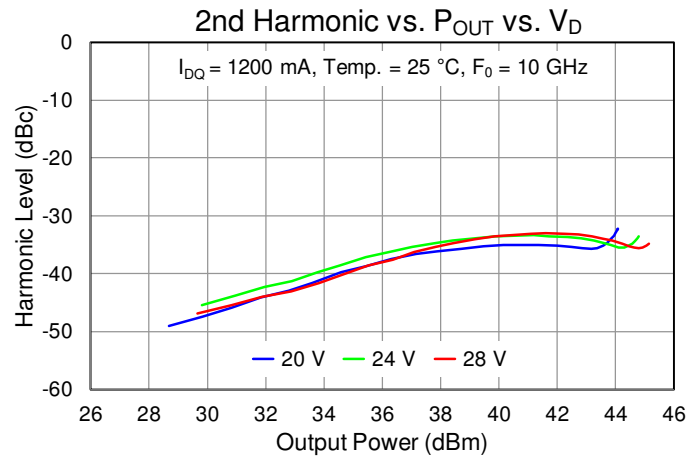
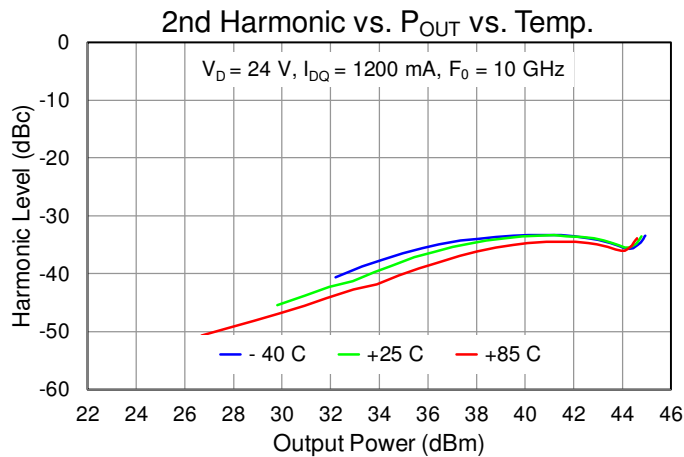
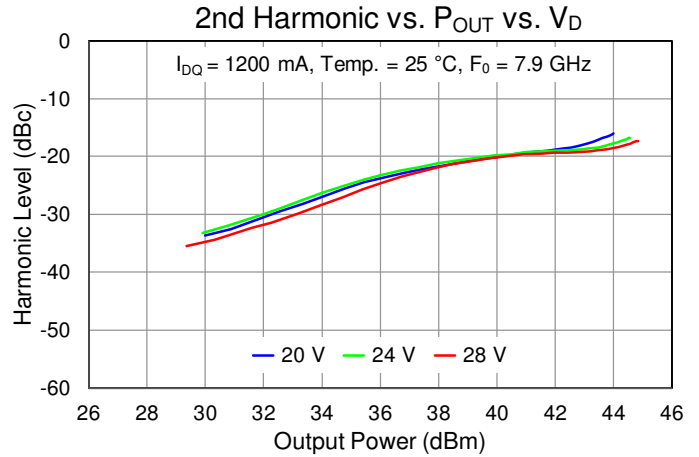
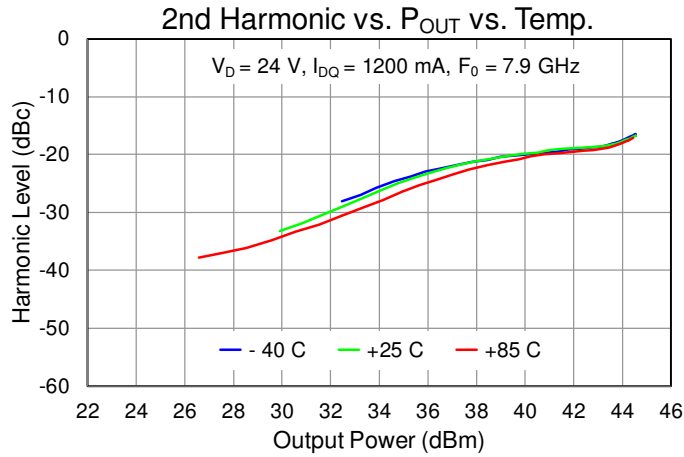
Performance Plots – Linearity



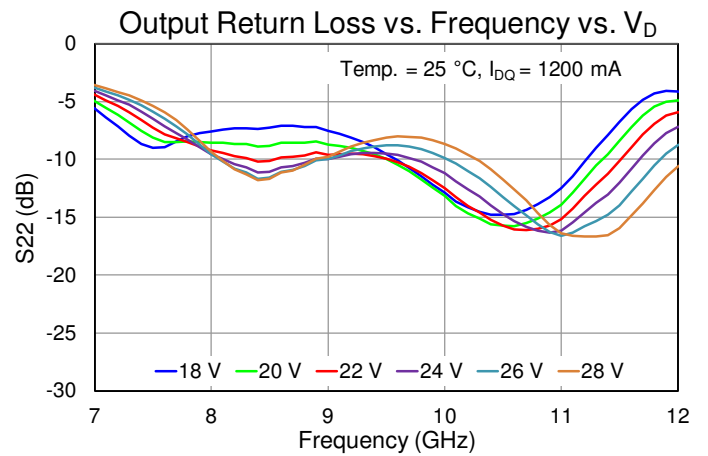
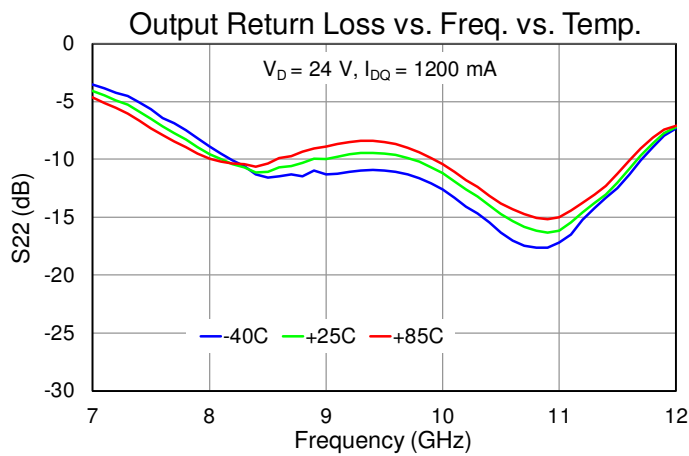
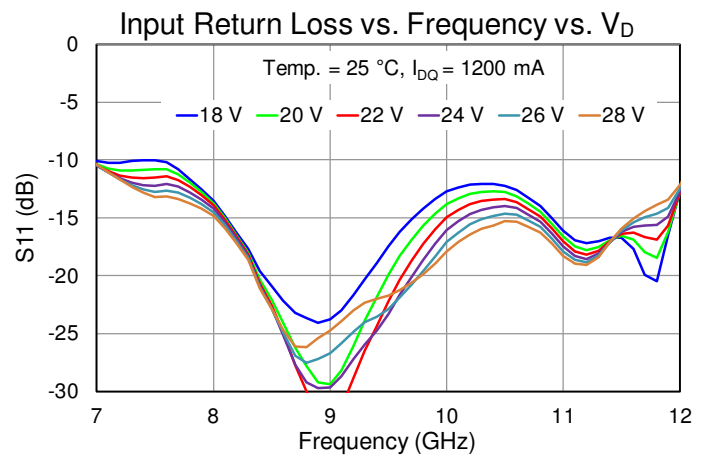
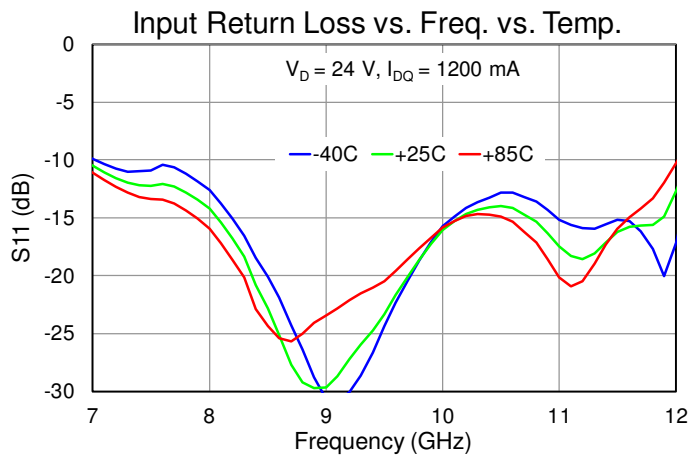
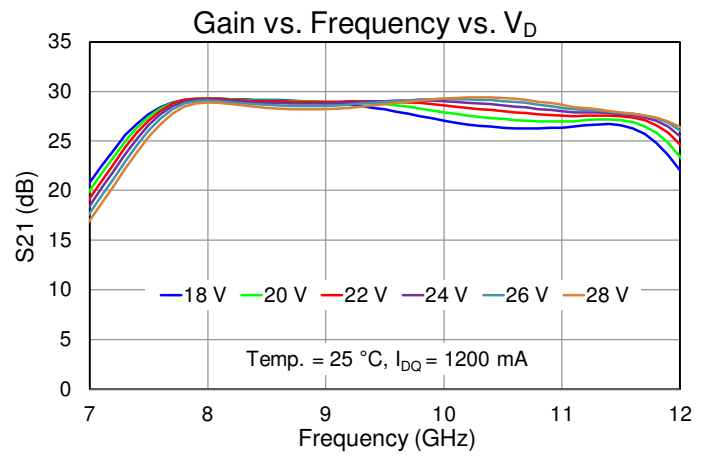
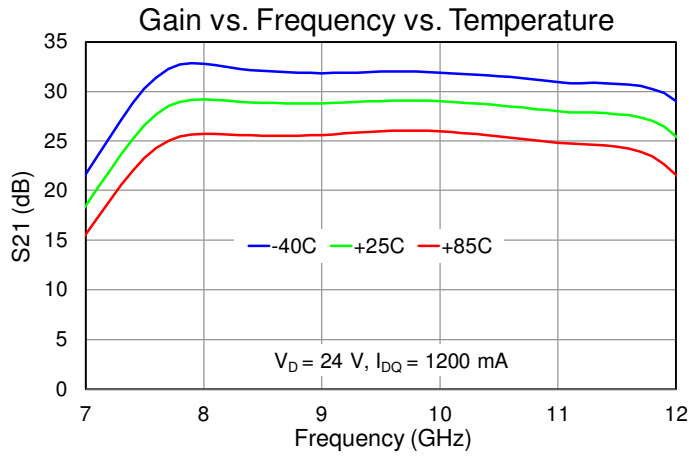
Performance Plots – Linearity



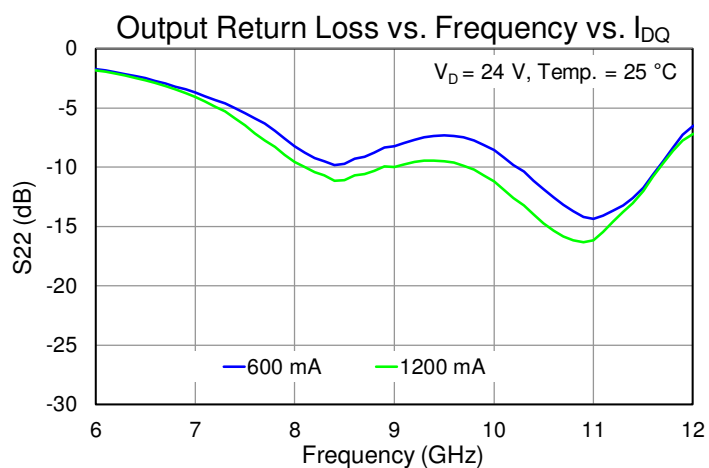
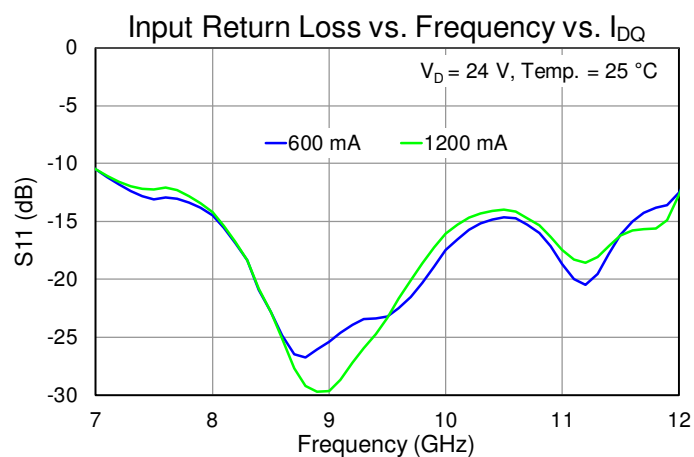
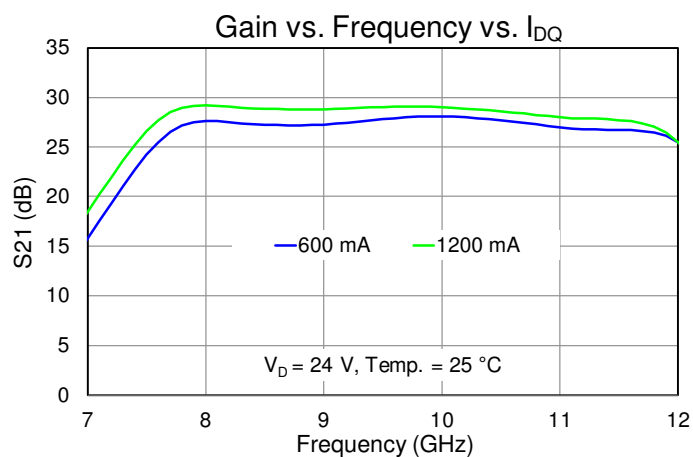
Performance Plots – Harmonics



Performance Plots – Small Signal



Performance Plots – Small Signal



Thermal and Reliability Information

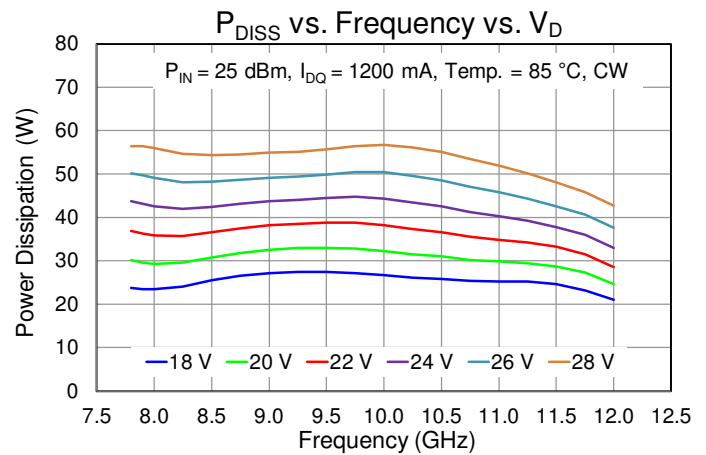
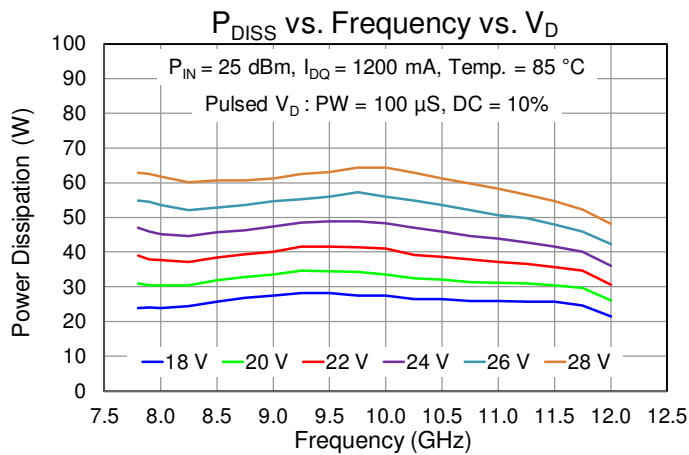
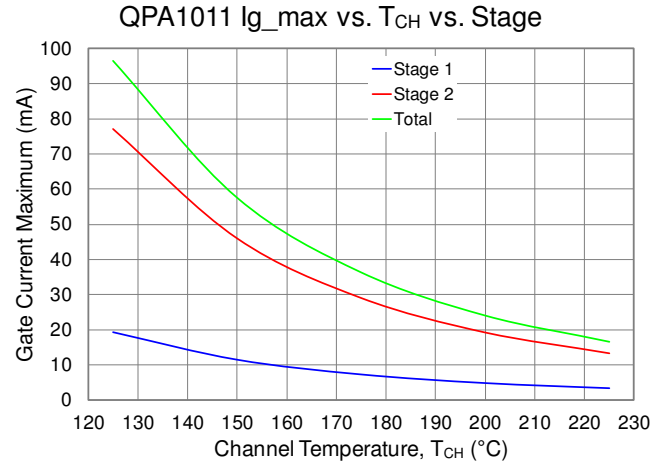
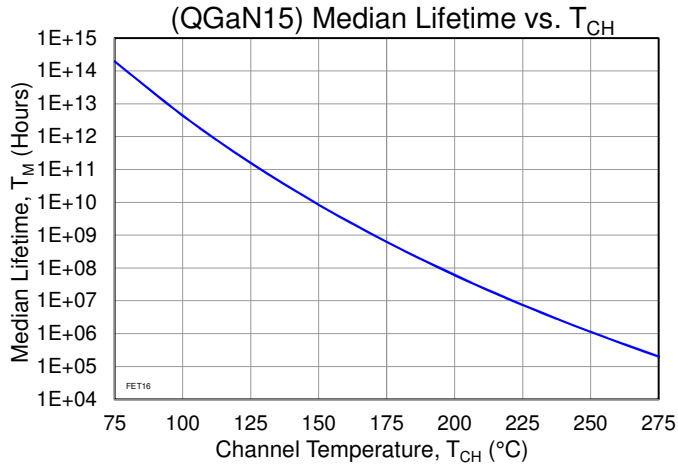
| Parameter | Test Conditions | Value | Units |
|---|--|----------|-------|
| Thermal Resistance (θ_{JC}) ⁽¹⁾ | T _{BASE} = 85 °C, V _D = +24 V, I _{DQ} = 1200 mA, Pulsed V _D : PW = 100 us; DC = 10%, Freq = 9.75 GHz, P _{IN} = 25 dBm, I _{D_Drive} = 3.3 A, P _{OUT} = 44.7 dBm, P _{DISS} = 48.9 W | 1.49 | °C/W |
| Channel Temperature (T _{CH}) (Under RF drive) | | 158 | °C |
| Median Lifetime (T _M) | | 3.6E +09 | Hrs |
| Thermal Resistance (θ_{JC}) ⁽¹⁾ | T _{BASE} = 85 °C, V _D = +24V, I _{DQ} = 1200 mA, CW, P _{DISS} = 28.8 W | 2.13 | °C/W |
| Channel Temperature (T _{CH}) (Quiescent, No RF) | | 147 | °C |
| Median Lifetime (T _M) | | 1.2E 10 | Hrs |
| Thermal Resistance (θ_{JC}) ⁽¹⁾ | T _{BASE} = 85 °C, V _D = +24 V, I _{DQ} = 1200 mA, CW, Freq = 9.75 GHz, P _{IN} = 25 dBm, I _{D_Drive} = 2.9 A, P _{OUT} = 44.2 dBm, P _{DISS} = 44.7 W | 2.08 | °C/W |
| Channel Temperature (T _{CH}) (Under RF drive) | | 178 | °C |
| Median Lifetime (T _M) | | 4.7E +08 | Hrs |
| Thermal Resistance (θ_{JC}) ⁽¹⁾ | T _{BASE} = 85 °C, V _D = +20 V, I _{DQ} = 1200 mA, Pulsed V _D : PW = 100 us; DC = 10%, Freq = 9.25 GHz, P _{IN} = 25 dBm, I _{D_Drive} = 3.0 A, P _{OUT} = 44.1 dBm, P _{DISS} = 34.6 W | 1.39 | °C/W |
| Channel Temperature (T _{CH}) (Under RF drive) | | 133 | °C |
| Median Lifetime (T _M) | | 6.0E +10 | Hrs |
| Thermal Resistance (θ_{JC}) ⁽¹⁾ | T _{BASE} = 85 °C, V _D = +20V, I _{DQ} = 1200 mA, CW, P _{DISS} = 24 W | 2.13 | °C/W |
| Channel Temperature (T _{CH}) (Quiescent, No RF) | | 136 | °C |
| Median Lifetime (T _M) | | 4.2E +10 | Hrs |
| Thermal Resistance (θ_{JC}) ⁽¹⁾ | T _{BASE} = 85 °C, V _D = +20 V, I _{DQ} = 1200 mA, CW, Freq = 9.5GHz, P _{IN} = 25 dBm, I _{D_Drive} = 2.8 A, P _{OUT} = 43.7 dBm, P _{DISS} = 33 W | 1.94 | °C/W |
| Channel Temperature (T _{CH}) (Under RF drive) | | 149 | °C |
| Median Lifetime (T _M) | | 9.4E +09 | Hrs |

Notes:

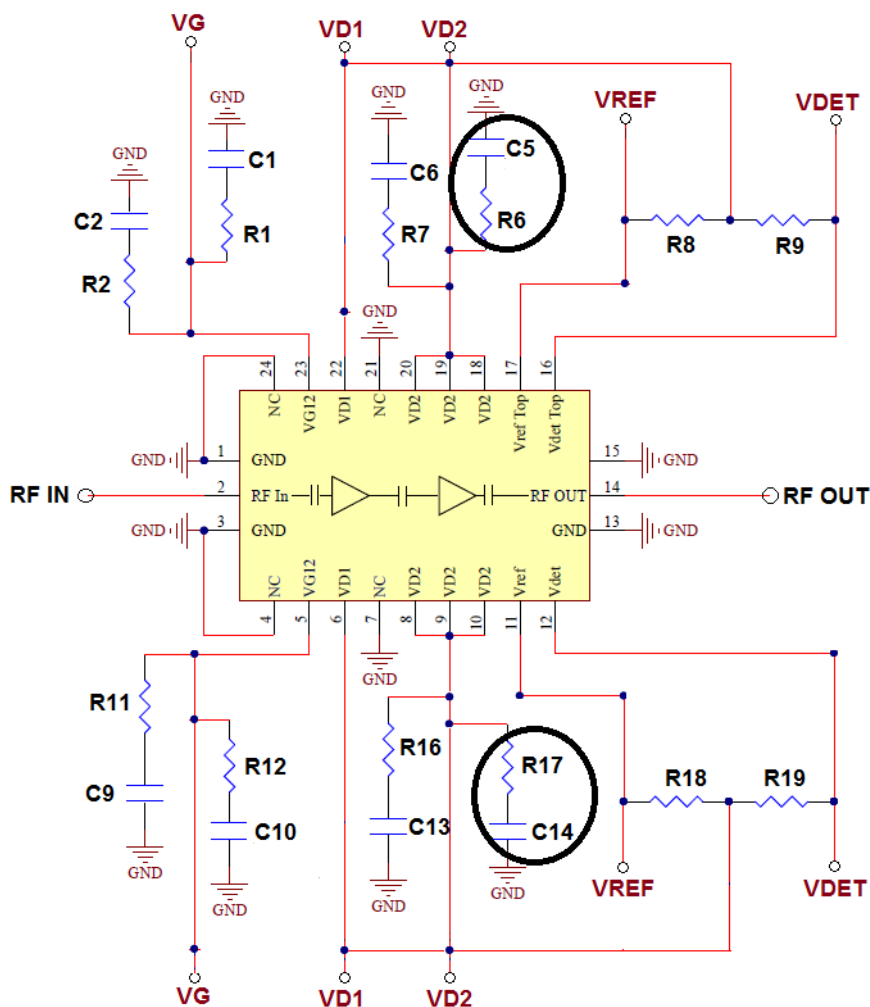
- Thermal resistance is measured to the package backside.

Median Lifetime

Median Life Test Conditions: $V_D = +28\text{ V}$; Failure Criteria = 10 % reduction in I_{D_MAX} during DC Life Testing



Applications Circuit for Linear and Pulsed Operations



Note: $V_{\Delta} = V_{REF} - V_{DET}$

- QPA1011 can be biased from either the top side or bottom side.
- V_{D1} and V_{D2} need to be tied together
- V_{D1} / V_{D2} and V_{REF} / V_{DET} have to be on the same side for V_{Δ} to work.
- Bypassing components required for the side(s) being biased.
- The extra bias components (R6, R17, C5 and C14) are required for optimum linearity.

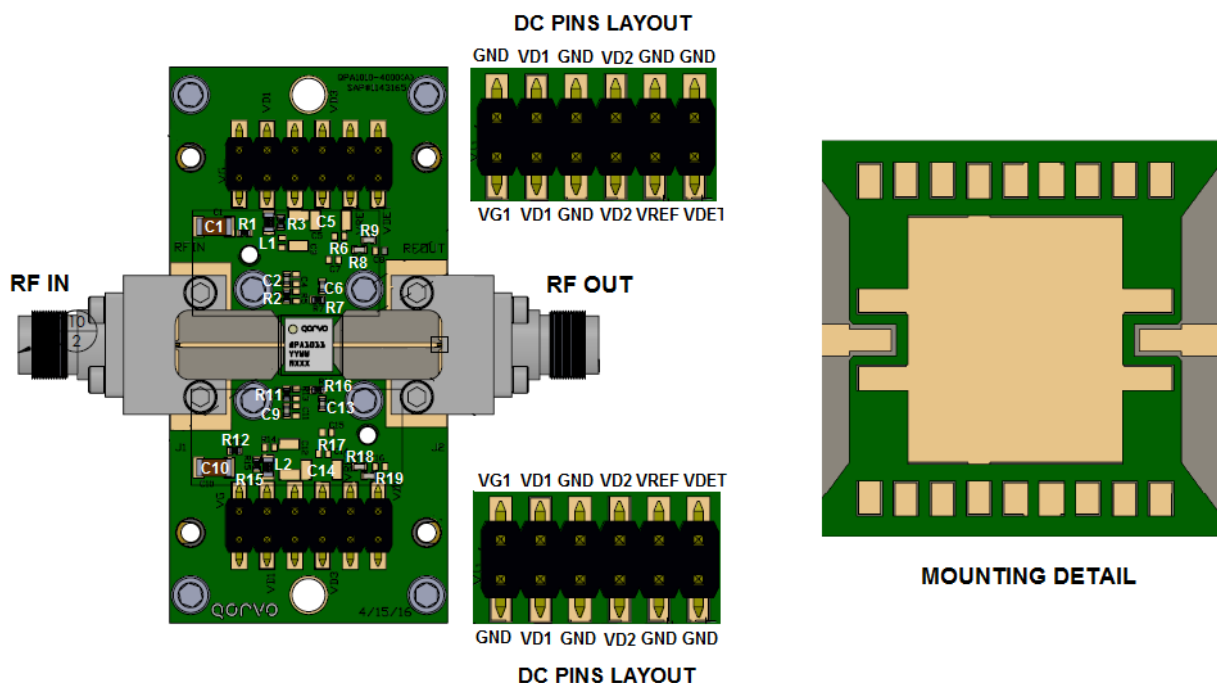
Bias Up Procedure

1. Set I_D limit to 4000 mA, I_G limit to 20 mA
2. Apply -5 V to V_G
3. Apply $+24$ V to V_D ; ensure I_{DQ} is approx. 0 mA
4. Adjust V_G until $I_{DQ} = 1200$ mA ($V_G \sim -1.9$ V Typ.).
5. Turn on RF supply

Bias Down Procedure

1. Turn off RF supply
2. Reduce V_G to -5 V; ensure I_{DQ} is approx. 0 mA
3. Set V_D to 0 V
4. Turn off V_D supply
5. Turn off V_G supply

Evaluation Board (EVB) Layout Assembly for Pulsed Operation



Note: PCB is a multilayer

1. All 4 metal thicknesses are 0.5 oz
2. Upper core 1 is Rogers 4003C, 8 mil thick
3. Lower core 2 is 370HR, 6 mil thick
4. Pre-Preg is an epoxy coated glass fabric
5. Total finished PCB thickness is 25 ±3 mil
6. This EVB uses a copper-coined PCB for optimum thermal management under high dissipation long pulse and/or CW conditions

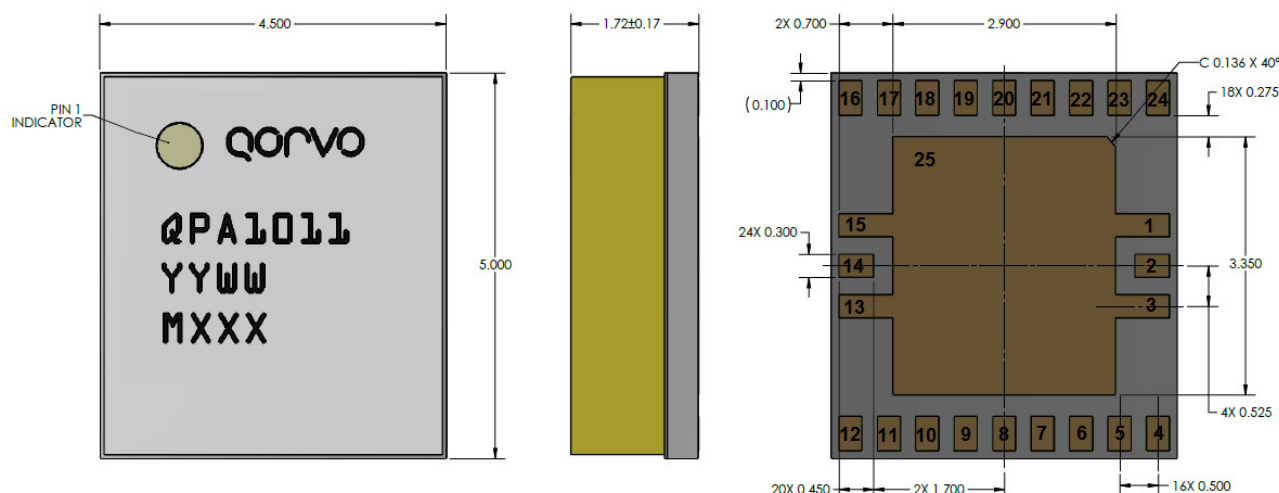
Bill of Materials for EVB

| Reference Des. | Value | Description | Manuf. | Part Number |
|---|------------|----------------------------|---------|-------------|
| C1, C5, C10, C14 | 10 uF | CAP, 1206, 50 V, 20 %, X5R | Various | – |
| C2, C6, C9, C13 | 0.01 uF | CAP, 0402, 50 V, 10 %, X7R | Various | – |
| R1, R12 | 5.1 Ohm | RES, 0402, 50V, 5 %, SMT | Various | – |
| R2, R3, R6, R7, R11, R15, R16, R17 ⁽¹⁾ | 0 Ohm | RES, 0402, 5 %, SMD | Various | – |
| R8, R9, R18, R19 | 25.5 K Ohm | RES, 0402, 1/16W, 1%, 0402 | Various | – |
| L1, L2 ⁽¹⁾ | 0 Ohm | RES, 0603, 1/10 W | Various | – |

Note:

1. These components are acting as the jumpers for this EVB.

Mechanical Information



Units: millimeters

Tolerances: unless specified

x.xx = ± 0.25

x.xxx = ± 0.100

Materials:

Base: Laminate

Lid: FR4

All metalized features are gold plated

Part is epoxy sealed

Marking:

QPA1011: Part number

YY: Part Assembly year

WW: Part Assembly week

MXXX: Batch ID

Pin Description

| Pad No. | Symbol | Description |
|----------------------|-------------------|---|
| 1, 3, 13, 15, Center | GND | Ground. Must be grounded on the PCB. Conductive filled vias recommended for least inductance and improved thermal performance |
| 2 | RF _{IN} | RF Input; matched to 50 Ω; DC blocked |
| 4, 7, 21, 24 | N/C | Not connected internally. Recommended to be grounded |
| 5, 23 | V _{G1-2} | Stage 1-2 Gate Voltage. Bias network is required; see recommended Application Information above on page 21 |
| 6, 22 | V _{D1} | Stage 1 Drain Voltage. Bias network is required; see recommended Application Information above on page 21 |
| 8 – 10, 18 - 20 | V _{D2} | Stage 2 Drain voltage; Bias network is required; must be biased from both sides; see recommended Application Information above on page 21 |
| 11, 17 | V _{REF} | Reference voltage |
| 12, 16 | V _{DET} | Detector voltage |
| 14 | RF _{OUT} | RF Output; matched to 50 Ω; DC blocked |

Handling Precautions

| Parameter | Rating | Standard |
|----------------------------------|--------|------------------------------------|
| ESD – Human Body Model (HBM) | TBD | ESDA / JEDEC JS-001-2012 |
| ESD – Charged Device Model (CDM) | TBD | ESDA / JEDEC JS-002-2014 |
| MSL – Convection Reflow 260 °C | TBD | JEDEC standard IPC/JEDEC J-STD-020 |



Caution!
ESD-Sensitive Device

Solderability

Compatible with the latest version of J-STD-020, Lead-free solder, 260 °C

RoHS Compliance

This product is compliant with the 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment), as amended by Directive 2015/863/EU. This product also has the following attributes:

- Lead Free
- Antimony Free
- TBBP-A (C₁₅H₁₂Br₄O₂) Free
- PFOS Free
- SVHC Free
- Qorvo Green



Contact Information

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Web: www.qorvo.com

Email: customer.support@qorvo.com

For technical questions and application information: **Email:** sjcapapplications.engineering@qorvo.com

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